











ADS54J69

ZHCSEJ4C -MAY 2015-REVISED JANUARY 2017

# ADS54J69 双通道、16 位、500MSPS 模数转换器

# 1 特性

- 16 位分辨率、双通道、500 MSPS 模数转换器 (DAC)
- 空闲通道噪底: -159dBFS/Hz
- 频谱性能(-1dBFS 时的 f<sub>IN</sub> = 170MHz):
  - 信噪比 (SNR): 73dBFS
  - 噪声频谱密度 (NSD): -157dBFS/Hz
  - 无杂散动态范围 (SFDR): 93dBc
  - SFDR: 94dBc(不包括 HD2、HD3 和交错音调)
- 频谱性能(-1dBFS 时的 f<sub>IN</sub> = 310MHz):
  - SNR: 71.7dBFS
  - NSD: -155.7dBFS/Hz
  - SFDR: 81dBc
  - SFDR: 94dBc(不包括 HD2、HD3 和交错音调)
- 通道隔离: f<sub>IN</sub> = 170MHz 时为 100dBc
- 输入满量程: 1.9 V<sub>PP</sub>
- 输入带宽 (3dB): 1.2GHz
- 片上抖动
- 集成 2 倍抽取率滤波器
- 支持 JESD204B 子类 1 接口:
  - 10.0Gbps 时每个 ADC 1 条通道
  - 5.0Gbps 时每个 ADC 2 条通道
  - 支持多芯片同步
- 功耗: 500MSPS 时为 1.35W/通道
- 72 引脚超薄型四方扁平无引线 (VQFN) 封装 (10mm × 10mm)

## 2 应用

- 雷达和天线阵列
- 无线宽带
- 电缆 CMTS、DOCSIS 3.1 接收器
- 通信测试设备
- 微波接收器
- 软件定义无线电 (SDR)
- 数字转换器
- 医疗成像和诊断功能

# 3 说明

ADS54J69 是一款低功耗、高带宽 16 位、500MSPS 双通道模数转换器 (ADC)。该器件经设计具有高信噪比 (SNR),可提供 -159dBFS/Hz 的噪底,从而 协助应用在宽瞬时带宽内 实现最高动态范围。该器件支持JESD204B 串行接口,数据传输速率高达 10Gbps,每个 ADC 可支持 1 或 2 条通道。经缓冲的模拟输入可在较宽频率范围内提供统一输入阻抗并最大程度地降低采样和保持毛刺脉冲能量。可选择将每条 ADC 通道直接与宽带数字下变频器 (DDC) 模块相连。ADS54J69以超低功耗在宽输入频率范围内提供出色的无杂散动态范围 (SFDR)。

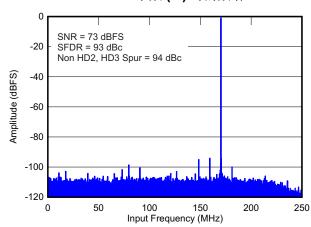
JESD204B 接口减少了接口线路数,从而实现高系统集成度。内部锁相环 (PLL) 会将 ADC 采样时钟加倍,以获得串行化各通道的 16 位数据时所使用的位时钟。

### 器件信息

器件编号	封装	封装尺寸 (标称值)
ADS54J69	VQFNP (72)	10.00mm x 10.00mm

(1) 要了解所有可用封装,请参见数据表末尾的可订购产品附录。

#### 170MHz 中频 (IF) 时的频谱





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# 4 修订历史记录

注: 之前版本的页码可能与当前版本有所不同。

Changes from Revision B (February 2016) to Revision C	Page
Added Device Comparison Table	5
Added the FOVR latency parameter to the Timing Characteristics table	12
Added SYSREF Not Present (Subclass 0, 2) section	27
Changed the number of clock cycles in the Fast OVR section	28
Changed the Register Map	40
Deleted register 39h, 3Ah, and 56h	40
Changed the SNR versus Input Frequency and External Clock Jitter figure	67
Changed Power Supply Recommendations section	
Added the Power Sequencing and Initialization section	71
• 己添加 文档支持和接收文档更新通知部分	74
• 己添加 接收文档更新通知部分	

CI	hanges from Revision A (January 2016) to Revision B	Page
•	Changed Sample Timing, Aperture jitter parameter in Timing Characteristics table	12
•	Changed Table 35	5
•	Changed Table 42	54
•	Changed Table 44	55
•	Changed SNR and Clock Jitter section: changed Figure 130 and last sentence of section	67
•	Changed Application Curves section	70





Changes from Original (May 2015) to Revision A	
• 已发布为"量产数据"	1

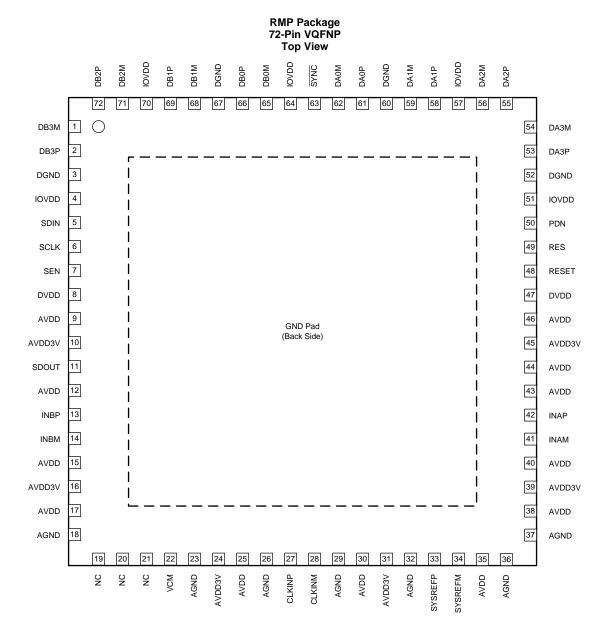


# 5 Device Comparison Table

PART NUMBER	SPEED GRADE (MSPS)	RESOLUTION (Bits)	CHANNEL
ADS54J20	1000	12	2
ADS54J42	625	14	2
ADS54J40	1000	14	2
ADS54J60	1000	16	2
ADS54J66	500	14	4
ADS54J69	500	16	2



# 6 Pin Configuration and Functions





## **Pin Functions**

	PIN			
NAME	NO.	1/0	DESCRIPTION	
CLOCK, SYS	REF			
CLKINM	28	I	Negative differential clock input for the ADC	
CLKINP	27	1	Positive differential clock input for the ADC	
SYSREFM	34	I	Negative external SYSREF input	
SYSREFP	33	I	Positive external SYSREF input	
CONTROL, S	ERIAL INTERFACE			
PDN	50	I/O	Power-down. Can be configured via an SPI register setting. Can be configured to fast overrange output for channel A via the SPI.	
RESET	48	I	Hardware reset; active high. This pin has an internal 20-kΩ pulldown resistor.	
SCLK	6	I	Serial interface clock input	
SDIN	5	I	Serial interface data input	
SDOUT	11	0	Serial interface data output. Can be configured to fast overrange output for channel B via the SPI.	
SEN	7	I	Serial interface enable	
DATA INTER	FACE			
DA0M	62			
DA1M	59	0	IECD204P parial data pagativa autouta for channel A	
DA2M	56	U	JESD204B serial data negative outputs for channel A	
DA3M	54			
DA0P	61			
DA1P	58	0	JESD204B serial data positive outputs for channel A	
DA2P	55	O	3ESD204B Serial data positive outputs for charmer A	
DA3P	53			
DB0M	65			
DB1M	68	0	IECD204P parial data pagative autouts for channel P	
DB2M	71	O	JESD204B serial data negative outputs for channel B	
DB3M	1			
DB0P	66			
DB1P	69	0	JESD204B serial data positive outputs for channel B	
DB2P	72	O	3E3D204B Serial data positive outputs for charmer B	
DB3P	2			
SYNC	63	I	Synchronization input for JESD204B port	
INPUT, COM	MON MODE			
INAM	41	I	Differential analog negative input for channel A	
INAP	42	I	Differential analog positive input for channel A	
INBM	14	I	Differential analog negative input for channel B	
INBP	13	ı	Differential analog positive input for channel B	
VCM	22	0	Common-mode voltage, 2.1 V. Note that analog inputs are internally biased to this pin through 600 $\Omega$ (effective), no external connection from the VCM pin to the INxP or INxM pin is required.	
POWER SUP	PLY			
AGND	18, 23, 26, 29, 32, 36, 37	ı	Analog ground	
AVDD	9, 12, 15, 17, 25, 30, 35, 38, 40, 43, 44, 46	1	Analog 1.9-V power supply	
AVDD3V	10, 16, 24, 31, 39, 45	I	Analog 3.0-V power supply for the analog buffer	
DGND	3, 52, 60, 67	I	Digital ground	
DVDD	8, 47	I	Digital 1.9-V power supply	
IOVDD	4, 51, 57, 64, 70	I	Digital 1.15-V power supply for the JESD204B transmitter	
NC, RES				
NC	19, 20, 21		Unused pins, do not connect	
RES	49	I	Reserved pin. Connect to DGND.	



# 7 Specifications

# 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

		MIN	MAX	UNIT
	AVDD3V	-0.3	3.6	
Supply voltage range	AVDD	-0.3	2.1	V
Supply voltage range	DVDD	-0.3	2.1	V
	IOVDD	-0.3 3.6  -0.3 2.1  -0.3 2.1  -0.3 2.1  -0.2 1.4  -0.3 0.3  -0.3 3  -0.3 AVDD + 0.3  -0.3 AVDD + 0.3		
Voltage between AGND and D	OGND	-0.3	0.3	V
	INAP, INBP, INAM, INBM	-0.3	3	
Valtage applied to input pine	AVDD3V -0.3 3.6  AVDD -0.3 2.1  DVDD -0.3 2.1  IOVDD -0.3 2.1  IOVDD -0.2 1.4  O and DGND -0.3 0.3  INAP, INBP, INAM, INBM -0.3 3  CLKINP, CLKINM -0.3 AVDD + 0.3  SYSREFP, SYSREFM -0.3 AVDD + 0.3  SCLK, SEN, SDIN, RESET, SYNC, PDN -0.2 2.1	AVDD + 0.3	V	
Voltage applied to input pins	SYSREFP, SYSREFM	-0.3	AVDD + 0.3	V
	AVDD3V       -0.3       3.6         AVDD       -0.3       2.1         DVDD       -0.3       2.1         IOVDD       -0.2       1.4         DGND       -0.3       0.3         INAP, INBP, INAM, INBM       -0.3       3         CLKINP, CLKINM       -0.3       AVDD + 0.3         SYSREFP, SYSREFM       -0.3       AVDD + 0.3         SCLK, SEN, SDIN, RESET, SYNC, PDN       -0.2       2.1	2.1		
Storage temperature, T <sub>stg</sub>		-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 7.2 ESD Ratings

			VALUE	UNIT
V	Floatroctatio discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)	±1000	\/
V <sub>(ESD)</sub>	Electrostatic discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 (2)	±500	V

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

# 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)(1)(2)

			MIN	NOM	MAX	UNIT
	AVDD3V		2.85	3.0	3.6	
Complementary name	AVDD		1.8	1.9	2.0	V
Supply voltage range	DVDD		1.7	1.9	2.0	
	IOVDD	1.1	1.15	1.2		
	Differential input voltage range			1.9		$V_{PP}$
Analog inputs	Input common-mode voltage			2.0		V
	Maximum analog input frequency for 1.9-V <sub>PP</sub> input amplitude <sup>(3)(4)</sup>			400		MHz
	Input clock frequency, device clock frequency		500		1000	MHz
	Input clock amplitude differential (V <sub>CLKP</sub> – V <sub>CLKM</sub> )	Sine wave, ac-coupled	0.75	1.5		
Clock inputs		LVPECL, ac-coupled	0.8	1.6		$V_{PP}$
		LVDS, ac-coupled		0.7		
	Input device clock duty cycle		45%	50%	55%	
Tomporoturo	Operating free-air, T <sub>A</sub>		-40		85	°C
Temperature	Operating junction, T <sub>J</sub>			105 <sup>(5)</sup>	125	-0

<sup>1)</sup> SYSREF must be applied for the device to initialize; see the SYSREF Signal section for details.

<sup>(2)</sup> JEDEC document JEP157 states that 250-V HBM allows safe manufacturing with a standard ESD control process.

<sup>(2)</sup> After power-up, always use a hardware reset to reset the device for the first time; see Table 60 for details.

<sup>(3)</sup> Operating 0.5 dB below the maximum-supported amplitude is recommended to accommodate gain mismatch in interleaving ADCs.

<sup>(4)</sup> At high frequencies, the maximum supported input amplitude reduces; see Figure 51 for details.

<sup>(5)</sup> Prolonged use above the nominal junction temperature can increase the device failure-in-time (FIT) rate.



### 7.4 Thermal Information

		ADS54J69	
	THERMAL METRIC <sup>(1)</sup>		UNIT
		72 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	22.3	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	5.1	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	2.4	°C/W
ΨЈТ	Junction-to-top characterization parameter	0.1	°C/W
ΨЈВ	Junction-to-board characterization parameter	2.3	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	0.4	°C/W

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

### 7.5 Electrical Characteristics

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
GENERAL						
	Device clock frequency				1000	MSPS
	Output sample rate				500	MSPS
	Resolution		16			Bits
POWER SUPP	LIES					
AVDD3V	3.0-V analog supply		2.85	3.0	3.6	V
AVDD	1.9-V analog supply		1.8	1.9	2.0	V
DVDD	1.9-V digital supply		1.7	1.9	2.0	V
IOVDD	1.15-V SERDES supply		1.1	1.15	1.2	V
I <sub>AVDD3V</sub>	3.0-V analog supply current	V <sub>IN</sub> = full-scale on both channels		293	360	mA
I <sub>AVDD</sub>	1.9-V analog supply current	V <sub>IN</sub> = full-scale on both channels		354	510	mA
I <sub>DVDD</sub>	1.9-V digital supply current			188	260	mA
I <sub>IOVDD</sub>	1.15-V SERDES supply current	Four-lane output mode (default after reset)		512	920	mA
P <sub>dis</sub>	Total power dissipation	(delault ditel reset)		2.66	3.1	W
I <sub>DVDD</sub>	1.9-V digital supply current			195		mA
I <sub>IOVDD</sub>	1.15-V SERDES supply current	Two-lane output mode		559		mA
P <sub>dis</sub>	Total power dissipation			2.73		W
	Global power-down power dissipation	Using the GLOBAL PDN register bit in the master page		204	315	mW



# 7.6 AC Characteristics

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
		$f_{IN} = 10 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		74.2		
		$f_{IN} = 140 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		73.4		
		$f_{IN} = 170 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$	71.3	73		
SNR	Signal-to-noise ratio	$f_{IN} = 210 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		72.7		dBFS
		$f_{IN} = 310 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		71.7		
		$f_{IN} = 370 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		70.3		
		$f_{IN} = 470 \text{ MHz}, A_{IN} = -3 \text{ dBFS}$		70.5		
		$f_{IN} = 10 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		158.2		
		$f_{IN} = 140 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		157.4		
		$f_{IN} = 170 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$	155.3	157.0		
NSD	Noise spectral density	$f_{IN} = 210 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		156.7		dBFS/Hz
		$f_{IN} = 310 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		155.7		
		$f_{IN} = 370 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		154.3		
		$f_{IN} = 470 \text{ MHz}, A_{IN} = -3 \text{ dBFS}$		154.5		
		f <sub>IN</sub> = 10 MHz, A <sub>IN</sub> = -1 dBFS		73.8		
		$f_{IN} = 140 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		73.3		
		$f_{IN} = 170 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$	69.8	72.9		dBFS
SINAD	Signal-to-noise and distortion ratio	$f_{IN} = 210 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		72.5		
		$f_{IN} = 310 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		71.2		
		$f_{IN} = 370 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		70.2		
		$f_{IN} = 470 \text{ MHz}, A_{IN} = -3 \text{ dBFS}$		69.4		
		f <sub>IN</sub> = 10 MHz, A <sub>IN</sub> = -1 dBFS		86		
		$f_{IN} = 140 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		95		
		$f_{IN} = 170 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$	79	94		
SFDR	Spurious free dynamic range (excluding IL spurs)	$f_{IN} = 210 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		89		dBc
	(excluding it spars)	$f_{IN} = 310 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		81		
		$f_{IN} = 370 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		87		
		$f_{IN} = 470 \text{ MHz}, A_{IN} = -3 \text{ dBFS}$		73		
		f <sub>IN</sub> = 10 MHz, A <sub>IN</sub> = -1 dBFS		86		
		f <sub>IN</sub> = 140 MHz, A <sub>IN</sub> = -1 dBFS		104		
		f <sub>IN</sub> = 170 MHz, A <sub>IN</sub> = -1 dBFS	85	102		
HD2	Second-order harmonic distortion	f <sub>IN</sub> = 210 MHz, A <sub>IN</sub> = -1 dBFS		95		dBc
		f <sub>IN</sub> = 310 MHz, A <sub>IN</sub> = -1 dBFS		81		
		f <sub>IN</sub> = 370 MHz, A <sub>IN</sub> = -1 dBFS		87		
		$f_{IN} = 470 \text{ MHz}, A_{IN} = -3 \text{ dBFS}$		96		
		$f_{IN} = 10 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		89		
		f <sub>IN</sub> = 140 MHz, A <sub>IN</sub> = -1 dBFS		103		
		$f_{IN} = 170 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$	86	101		
HD3	Third-order harmonic distortion	$f_{IN} = 210 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		100		dBc
		$f_{IN} = 310 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		98		
		$f_{IN} = 370 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		95		-
		$f_{IN} = 470 \text{ MHz}, A_{IN} = -3 \text{ dBFS}$		73		



# **AC Characteristics (continued)**

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
		$f_{IN} = 10 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		98		
		$f_{IN} = 140 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		95		
		$f_{IN} = 170 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$	84	94		
Non HD2, HD3	Spurious-free dynamic range (excluding HD2, HD3, and IL spur)	$f_{IN} = 210 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		89		dBc
1102, 1100	(excidenting Fib2, Fibo, and it spar)	$f_{IN} = 310 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		92		
		$f_{IN} = 370 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		97		
		$f_{IN} = 470 \text{ MHz}, A_{IN} = -3 \text{ dBFS}$		92		
		$f_{IN} = 10 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		12		
		f <sub>IN</sub> = 140 MHz, A <sub>IN</sub> = -1 dBFS		11.9		
		f <sub>IN</sub> = 170 MHz, A <sub>IN</sub> = -1 dBFS	11.3	11.9		
ENOB	Effective number of bits	f <sub>IN</sub> = 210 MHz, A <sub>IN</sub> = -1 dBFS		11.8		Bits
		f <sub>IN</sub> = 310 MHz, A <sub>IN</sub> = -1 dBFS		11.5		
		$f_{IN} = 370 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		11.4		
		$f_{IN} = 470 \text{ MHz}, A_{IN} = -3 \text{ dBFS}$		11.2		
	Total harmonic distortion	f <sub>IN</sub> = 10 MHz, A <sub>IN</sub> = -1 dBFS		84		dBc
		$f_{IN} = 140 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		95		
		f <sub>IN</sub> = 170 MHz, A <sub>IN</sub> = -1 dBFS	79	89		
THD		f <sub>IN</sub> = 210 MHz, A <sub>IN</sub> = -1 dBFS		85		
		$f_{IN} = 310 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		80		
		$f_{IN} = 370 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		85		
		$f_{IN} = 470 \text{ MHz}, A_{IN} = -3 \text{ dBFS}$		72		
		f <sub>IN</sub> = 10 MHz, A <sub>IN</sub> = -1 dBFS		90		
		f <sub>IN</sub> = 140 MHz, A <sub>IN</sub> = -1 dBFS		90		
		f <sub>IN</sub> = 170 MHz, A <sub>IN</sub> = -1 dBFS	75	87		
SFDR_IL	Interleaving spur	f <sub>IN</sub> = 210 MHz, A <sub>IN</sub> = -1 dBFS		85		dBc
		$f_{IN} = 310 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		85		
		$f_{IN} = 370 \text{ MHz}, A_{IN} = -1 \text{ dBFS}$		86		
		$f_{IN} = 470 \text{ MHz}, A_{IN} = -3 \text{ dBFS}$		82		
		$f_{IN1} = 185 \text{ MHz}, f_{IN2} = 190 \text{ MHz}, A_{IN} = -7 \text{ dBFS}$		86		
IMD3	Two-tone, third-order intermodulation distortion	$f_{IN1} = 365 \text{ MHz}, f_{IN2} = 370 \text{ MHz}, A_{IN} = -7 \text{ dBFS}$		79		dBFS
		$f_{IN1} = 465 \text{ MHz}, f_{IN2} = 470 \text{ MHz}, \\ A_{IN} = -10 \text{ dBFS}$		78		



# 7.7 Digital Characteristics

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
DIGITAL IN	NPUTS (RESET, SCLK, SEN, SDIN, SYN	C, PDN) <sup>(1)</sup>				
V <sub>IH</sub>	High-level input voltage	All digital inputs support 1.2-V and 1.8-V logic levels	0.8			V
V <sub>IL</sub>	Low-level input voltage	All digital inputs support 1.2-V and 1.8-V logic levels			0.4	V
	High level input gurrent	SEN		0		
IH	High-level input current	RESET, SCLK, SDIN, PDN, SYNC		50		μΑ
	Lavalara Linavitaria	SEN		50		
I <sub>IL</sub>	Low-level input current	RESET, SCLK, SDIN, PDN, SYNC		0		μA
DIGITAL IN	NPUTS (SYSREFP, SYSREFM)					
V <sub>D</sub>	Differential input voltage		0.35	0.45	1.4	V
V <sub>(CM_DIG)</sub>	Common-mode voltage for SYSREF <sup>(2)</sup>			1.3		V
	OUTPUTS (SDOUT, PDN <sup>(3)</sup> )					
V <sub>OH</sub>	High-level output voltage		DVDD - 0.1	DVDD		V
V <sub>OL</sub>	Low-level output voltage				0.1	V
DIGITAL O	UTPUTS (JESD204B Interface: DxP, Dx	M) <sup>(4)</sup>				
V <sub>OD</sub>	Output differential voltage	With default swing setting		700		${\rm mV}_{\rm PP}$
V <sub>oc</sub>	Output common-mode voltage			450		mV
	Transmitter short-circuit current	Transmitter pins shorted to any voltage between –0.25 V and 1.45 V	-100		100	mA
Z <sub>os</sub>	Single-ended output impedance			50		Ω
	Output capacitance	Output capacitance inside the device, from either output to ground		2		pF

<sup>(1)</sup> The RESET, SCLK, SDIN, and PDN pins have a 20-kΩ (typical) internal pulldown resistor to ground, and the SEN pin has a 20-kΩ (typical) pullup resistor to IOVDD.

<sup>(2)</sup> The SYSREFP and SYSREFM pins are internally biased to the 1.3-V common-mode voltage through a 5-kΩ resistor.

<sup>(3)</sup> When functioning as an OVR pin for channel B.

<sup>(4)</sup>  $100-\Omega$  differential termination.



## 7.8 Timing Characteristics

			MIN	TYP	MAX	UNITS
SAMPLE T	IMING				<u> </u>	
	Aperture delay		0.75		1.6	ns
	Aperture delay matching b	etween two channels on the same device		±70		ps
	Aperture delay matching b	etween two devices at the same temperature and supply voltage		±270		ps
	A	Actual jitter of sampling clock buffer	npling clock buffer 145			4
	Aperture jitter	Effective jitter after decimation filtering		102		f <sub>S</sub> rms
WAKE-UP	TIMING					
	Wake-up time to valid data	after coming out of global power-down		150		μs
LATENCY						
	Data latency <sup>(1)</sup> : ADC samp	ole to digital output		134 <sup>(2)</sup>		Input clock cycles
	OVR latency: ADC sample		62		Input clock cycles	
	FOVR latency: ADC sample	le to FOVR signal on pin	18	3 + 4 ns		Input clock cycles
t <sub>PD</sub>	Propagation delay: logic ga	ates and output buffers delay (does not change with f <sub>S</sub> )		4		ns
SYSREF T	IMING				,	
t <sub>SU_SYSREF</sub>	Setup time for SYSREF, re	eferenced to the input clock falling edge	300		900	ps
t <sub>H_SYSREF</sub>	Hold time for SYSREF, ref	erenced to the input clock falling edge	100			ps
JESD OUT	PUT INTERFACE TIMING	CHARACTERISTICS			,	
	Unit interval		100		400	ps
	Serial output data rate		2.5		10	Gbps
	Total jitter for BER of 1E-1	5 and lane rate = 10 Gbps		26		ps
	Random jitter for BER of 1	E-15 and lane rate = 10 Gbps		0.75		ps rms
	Deterministic jitter for BER	of 1E-15 and lane rate = 10 Gbps		12		ps, pk-pk
t <sub>R</sub> , t <sub>F</sub>		ne: rise and fall times are measured from 20% to 80%, m, 2.5 Gbps ≤ bit rate ≤ 10 Gbps		35		ps

- (1) Overall latency = data latency + decimation filter delay + t<sub>PDI</sub>.
- (2) Decimation filter latency is not included in this specification.

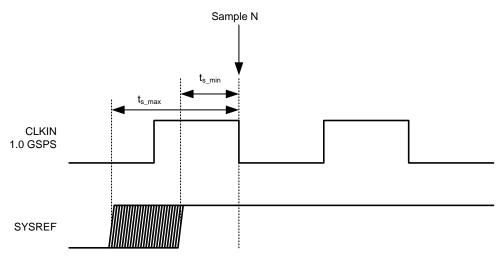


Figure 1. SYSREF Timing



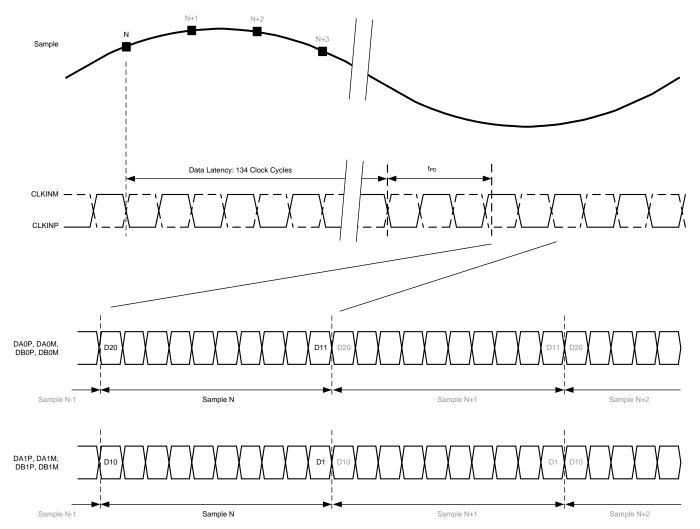
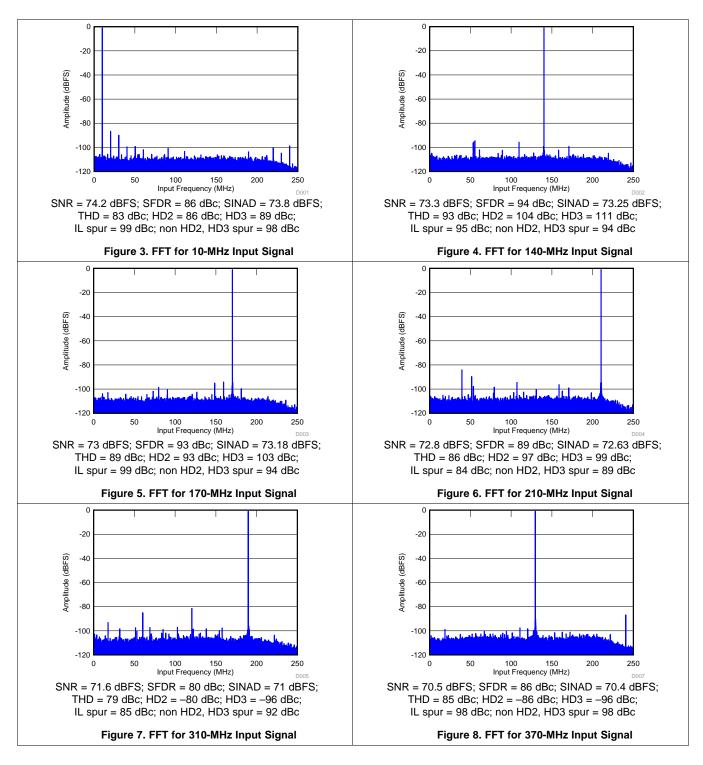


Figure 2. Sample Timing Requirements



### 7.9 Typical Characteristics





typical values are at  $T_A = 25$ °C, full temperature range is from  $T_{MIN} = -40$ °C to  $T_{MAX} = 85$ °C, device clock frequency = 1 GSPS, output sampling rate = 500 MSPS, 50% clock duty cycle, AVDD3V = 3.0 V, AVDD = DVDD = 1.9 V, IOVDD = 1.15 V, and -1-dBFS differential input (unless otherwise noted)

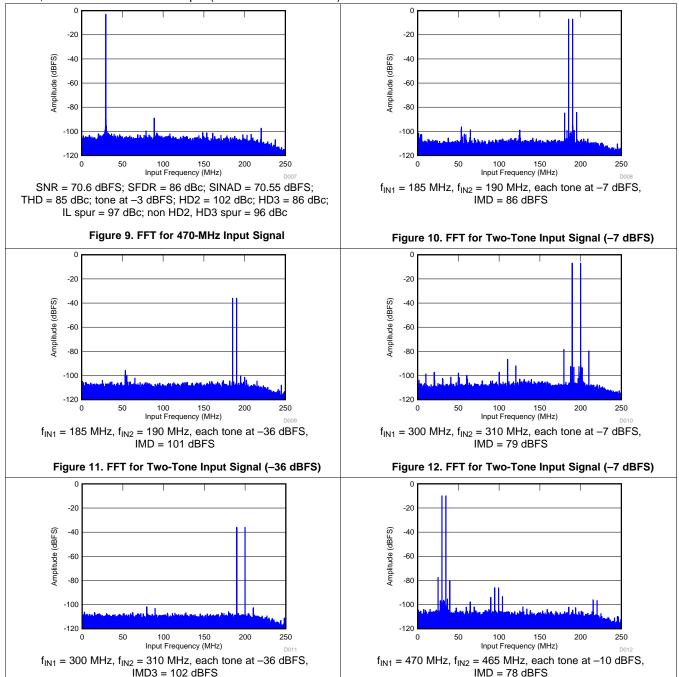


Figure 13. FFT for Two-Tone Input Signal (-36 dBFS)

Figure 14. FFT for Two-Tone Input Signal (-10 dBFS)



typical values are at  $T_A = 25$ °C, full temperature range is from  $T_{MIN} = -40$ °C to  $T_{MAX} = 85$ °C, device clock frequency = 1 GSPS, output sampling rate = 500 MSPS, 50% clock duty cycle, AVDD3V = 3.0 V, AVDD = DVDD = 1.9 V, IOVDD = 1.15 V, and -1-dBFS differential input (unless otherwise noted)

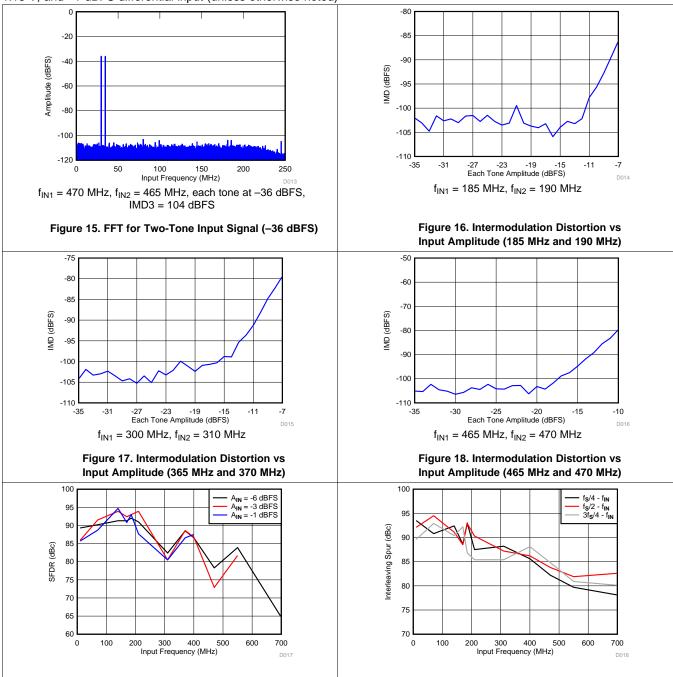
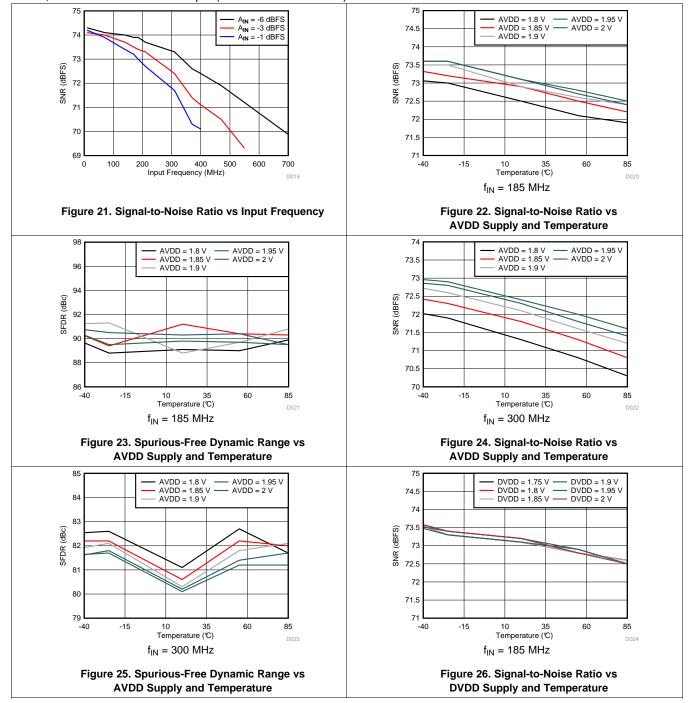


Figure 19. Spurious-Free Dynamic Range vs

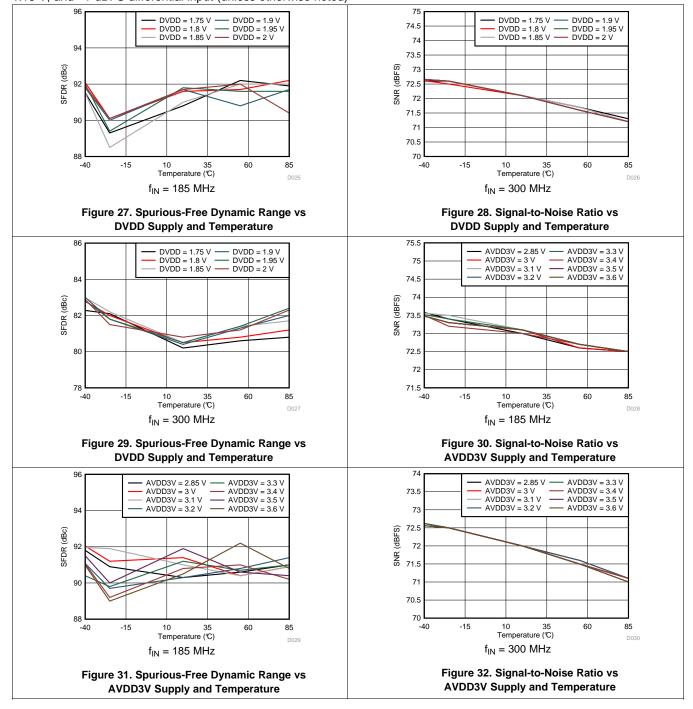
Input Frequency

Figure 20. IL Spur vs Input Frequency

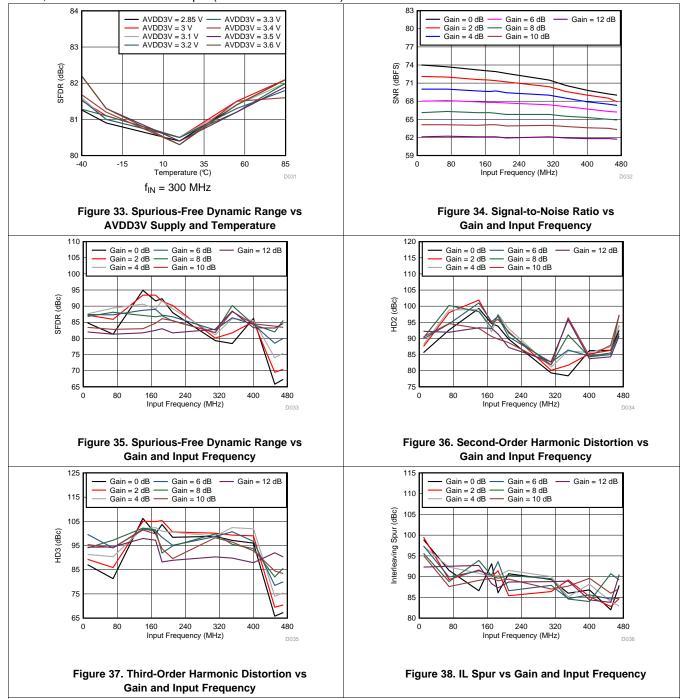




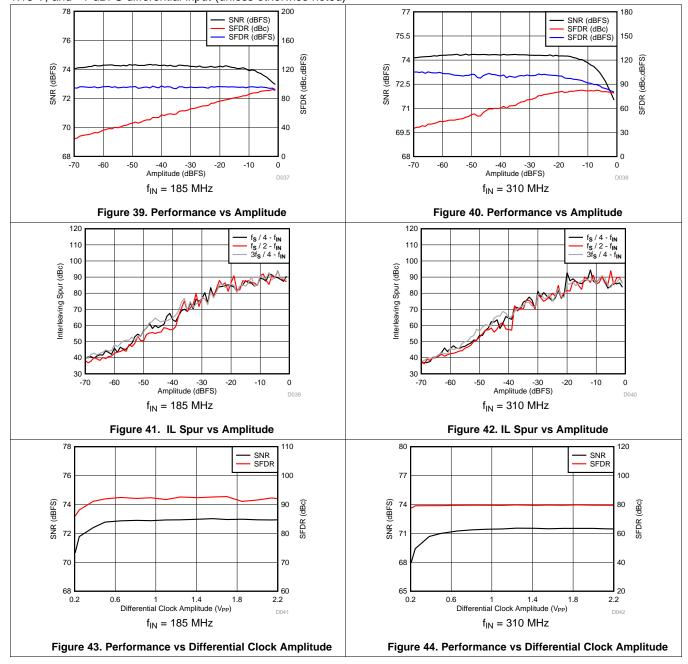




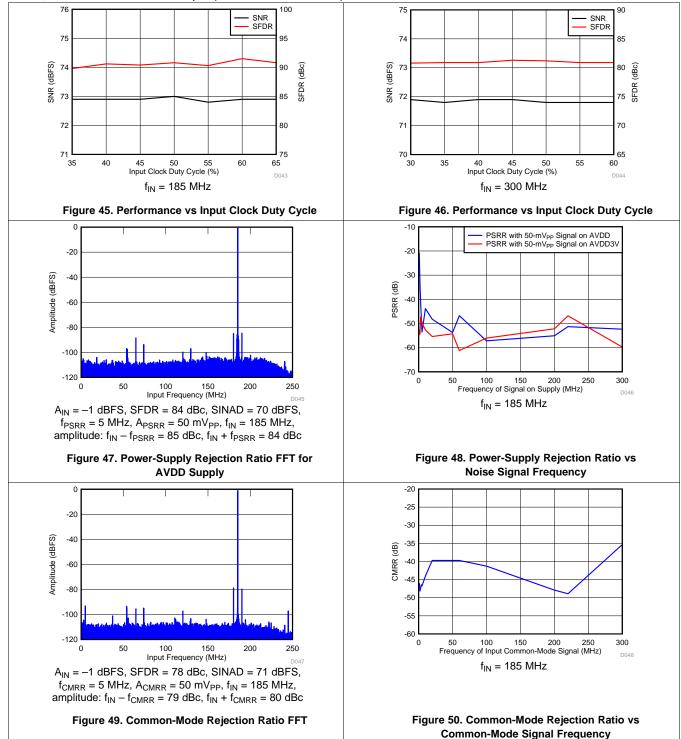




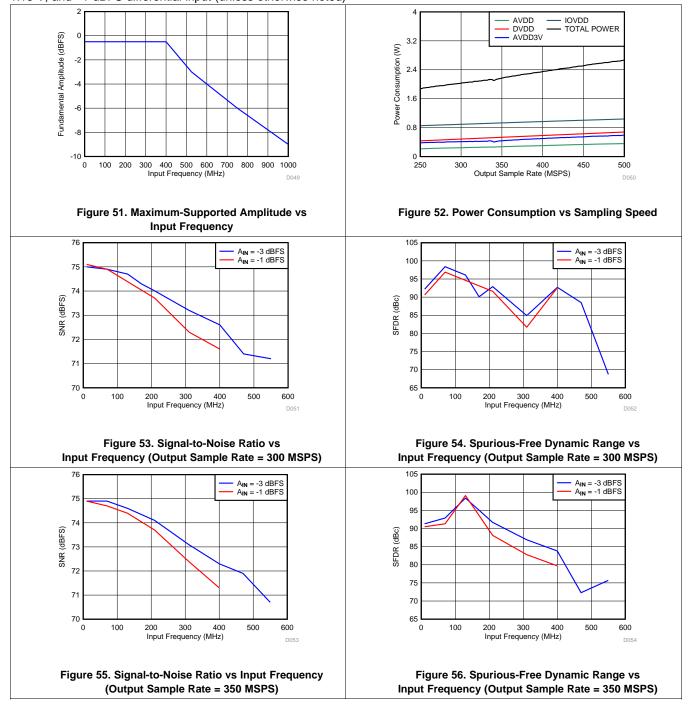














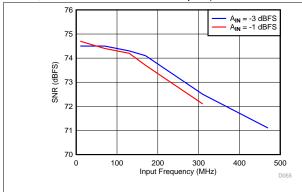


Figure 57. Signal-to-Noise Ratio vs Input Frequency (Output Sample Rate = 400 MSPS)

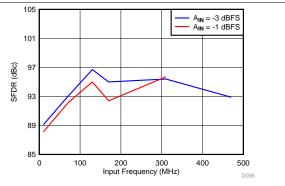


Figure 58. Spurious-Free Dynamic Range vs Input Frequency (Output Sample Rate = 400 MSPS)



# 8 Detailed Description

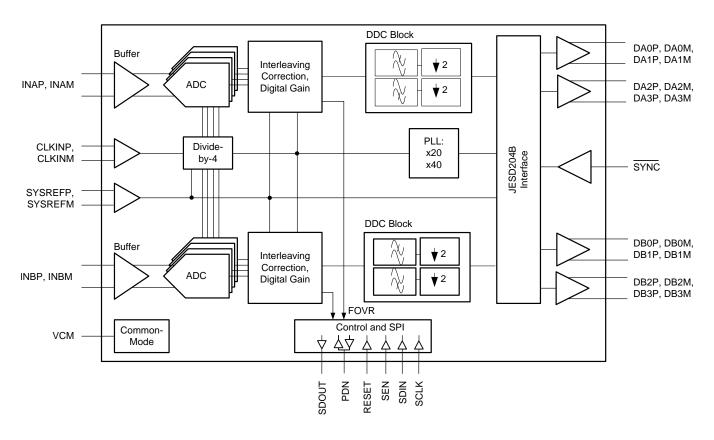
#### 8.1 Overview

The ADS54J69 is a low-power, wide-bandwidth, 16-bit, 500-MSPS, dual-channel, analog-to-digital converter (ADC). The ADS54J69 employs four interleaving ADCs for each channel to achieve a noise floor of –159 dBFS/Hz.

The ADS54J69 uses TI's proprietary interleaving and dither algorithms to achieve a clean spectrum with high spurious-free dynamic range (SFDR). Built-in, half-band, decimate-by-2 filters further enhance the capability of the ADS54J69 to deliver excellent signal-to-noise ratio (SNR) and SFDR over a wide range of frequencies. Analog input buffers isolate the ADC driver from glitch energy generated from sampling process, thereby simplify the driving network on-board.

The JESD204B interface reduces the number of interface lines with two-lane and four-lane options, allowing a high system integration density. The JESD204B interface operates in subclass-1, enabling multi-chip synchronization with the SYSREF input.

### 8.2 Functional Block Diagram





### 8.3 Feature Description

### 8.3.1 Analog Inputs

The ADS54J69 analog signal inputs are designed to be driven differentially. The analog input pins have internal analog buffers that drive the sampling circuit. As a result of the analog buffer, the input pins present a high impedance input across a very wide frequency range to the external driving source that enables great flexibility in the external analog filter design as well as excellent  $50-\Omega$  matching for RF applications. The buffer also helps isolate the external driving circuit from the internal switching currents of the sampling circuit, resulting in a more constant SFDR performance across input frequencies.

The common-mode voltage of the signal inputs is internally biased to VCM using  $600-\Omega$  resistors, allowing for accoupling of the input drive network. Each input pin (INP, INM) must swing symmetrically between (VCM + 0.475 V) and (VCM - 0.475 V), resulting in a 1.9-V<sub>PP</sub> (default) differential input swing. The input sampling circuit has a 3-dB bandwidth that extends up to 1.2 GHz. An equivalent analog input network diagram is shown in Figure 59.

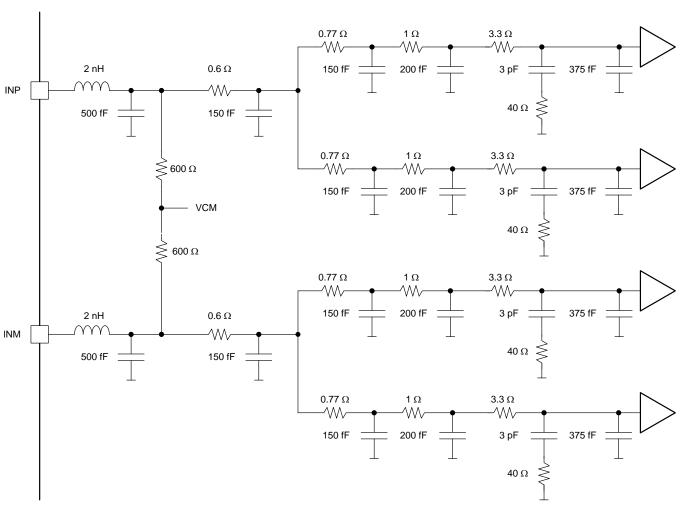


Figure 59. Analog Input Network

### **Feature Description (continued)**

The input bandwidth shown in Figure 60 is measured with respect to a  $50-\Omega$  differential input termination at the ADC input pins.

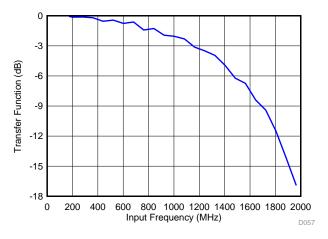


Figure 60. Transfer Function versus Frequency

#### 8.3.2 DDC Block

The ADS54J69 has an optional DDC block that can be enabled via an SPI register write. Each ADC channel is followed by a DDC block consisting of a decimate-by-2, half-band, finite impulse response (FIR) filter with low-pass and high-pass options programmable via the SPI interface.

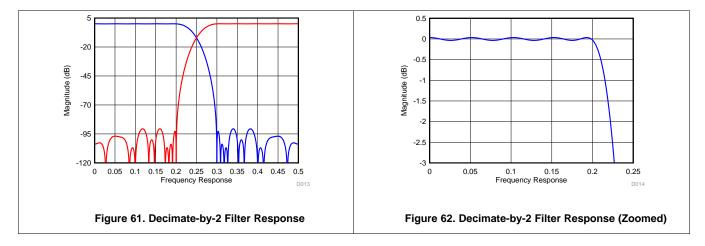
### 8.3.2.1 Decimate-by-2 Filter

This decimation filter has 41 taps. The stop-band attenuation is approximately 90 dB and the pass-band flatness is  $\pm 0.05$  dB. Table 1 shows corner frequencies for the low-pass and high-pass filter options.

Table 1. Corner Frequencies for the Decimate-by-2 Filter

CORNERS (dB)	LOW PASS	HIGH PASS
-0.1	0.202 <b>x</b> f <sub>S</sub>	0.298 <b>x</b> f <sub>S</sub>
-0.5	0.210 <b>x</b> f <sub>S</sub>	0.290 <b>x</b> f <sub>S</sub>
-1	0.215 <b>x</b> f <sub>S</sub>	0.285 <b>x</b> f <sub>S</sub>
-3	0.227 × f <sub>S</sub>	0.273 × f <sub>S</sub>

Figure 61 and Figure 62 show the frequency response of the decimate-by-2 filter from dc to f<sub>S</sub> / 2.





#### 8.3.3 SYSREF Signal

The SYSREF signal is a periodic signal that is sampled by the ADS54J69 device clock and used to align the boundary of the local multi-frame clock inside the data converter. SYSREF is required to be a sub-harmonic of the local multi-frame clock (LMFC) internal timing. To meet this requirement, the timing of SYSREF is dependent on the device clock frequency and the LMFC frequency, as determined by the selected DDC decimation and frames per multi-frame settings. The SYSREF signal is recommended be a low-frequency signal in the range of 1 MHz to 5 MHz in order to reduce coupling to the signal path both on the printed circuit board (PCB) as well as internal in the device.

The external SYSREF signal must be a sub-harmonic of the internal LMFC clock, as shown in Equation 1 and Table 2.

SYSREF = LMFC / 2N

where

(1)

**Table 2. LMFC Clock Frequency** 

LMFS CONFIGURATION	DECIMATION	LMFC CLOCK <sup>(1)(2)</sup>
4222	2X	(f <sub>S</sub> / 4) / k
2242	2X	(f <sub>S</sub> / 4) / k

- (1) K = Number of frames per multi-frame (JESD digital page 6900h, address 06h, bits 4-0).
- (2)  $f_S = \text{sampling (device) clock frequency.}$

#### 8.3.3.1 SYSREF Not Present (Subclass 0, 2)

A SYSREF pulse is required by the ADS54J69 to reset internal counters. If SYSREF is not present, as can be the case in subclass 0 or 2, this pulse can be done by doing the following register writes shown in Table 3.

Table 3. Internally Pulsing SYSREF Twice Using Register Writes

ADDRESS (Hex)	DATA (Hex)	COMMENT
0-011h	80h	Set the master page
0-054h	80h	Enable manual SYSREF
0-053h	01h	Set SYSREF high
0-053h	00h	Set SYSREF low
0-053h	01h	Set SYSREF high
0-053h	00h	Set SYSREF low

### 8.3.4 Overrange Indication

The ADS54J69 provides a fast overrange indication that can be presented in the digital output data stream via an SPI configuration. Alternatively, if not used, the SDOUT (pin 11) and PDN (pin 50) pins can be configured via the SPI to output the fast overrange (FOVR) indicator.

When the FOVR indication is embedded in the output data stream, the FOVR replaces the LSB of the 16-bit data stream going to the 8b/10b encoder, as shown in Figure 63.

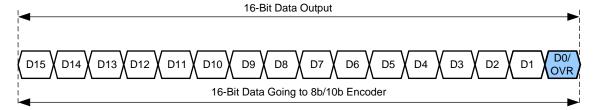


Figure 63. Overrange Indication in a Data Stream



#### 8.3.4.1 Fast OVR

The fast OVR is triggered if the input voltage exceeds the programmable overrange threshold and is presented after only 18 clock cycles +  $t_{PD}$  ( $t_{PD}$  of the gates and buffers is approximately 4 ns), thus enabling a quicker reaction to an overrange event.

The input voltage level at which the overload is detected is referred to as the *threshold*. The threshold is programmable using the FOVR THRESHOLD bits, as shown in Figure 64. The FOVR is triggered 18 clock cycles + t<sub>PD</sub> (t<sub>PD</sub> of the gates and buffers is approximately 4 ns) after the overload condition occurs.

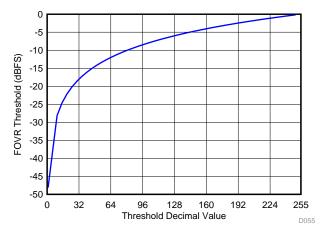


Figure 64. Programming Fast OVR Thresholds

The input voltage level at which the fast OVR is triggered is defined by Equation 2: Full-Scale × [Decimal Value of the FOVR Threshold Bits] / 255)

(2)

The default threshold is E3h (227d), corresponding to a threshold of -1 dBFS.

In terms of full-scale input, the fast OVR threshold can be calculated as Equation 3: 20log (FOVR Threshold / 255)

(3)



#### 8.3.5 Power-Down Mode

The ADS54J69 provides a highly-configurable power-down mode. Power-down can be enabled by using the PDN pin or via SPI register writes.

A power-down mask can be configured that allows a trade-off between wake-up time and power consumption in power-down mode. Two independent power-down masks can be configured: MASK 1 and MASK 2, as shown in Table 4. See the master page registers in Table 10 for further details.

Table 4. Register Address for Power-Down Modes

REGISTER ADDRESS	COMMENT		REGISTER DATA						
A[7:0] (Hex)		7	6	5	4	3	2	1	0
MASTER PAG	E (80h)								
20	MACKA		PDN ADC CHA			PDN ADC CHB			
21	MASK 1	PDN BUF	FER CHB	PDN BUFFER CHA		0	0	0	0
23	MASK 2		PDN AI	DC CHA		PDN ADC CHB			
24	WASK 2	PDN BUF	FER CHB	PDN BUF	FER CHA	0	0	0	0
26	CONFIG	GLOBAL PDN	OVERRIDE PDN PIN	PDN MASK SEL	0	0	0	0	0
53		0	MASK SYSREF	0	0	0	0	0	0
55		0	0	0	PDN MASK	0	0	0	0

To save power, the device can be put in complete power-down by using the GLOBAL PDN register bit. However, when the JESD link is required to be active during power-down, the ADC and analog buffer can be selectively powered down by using the PDN ADC CHx and PDN BUFFER CHx register bits after enabling the PDN MASK register bit. The PDN MASK SEL register bit can be used to select between MASK 1 or MASK 2. Table 5 shows power consumption for different combinations of the GLOBAL PDN, PDN ADC CHx, and PDN BUFF CHx register bits.

Table 5. Power Consumption in Different Power-Down Settings

REGISTER BIT	COMMENT	I <sub>AVDD3V</sub> (mA)	I <sub>AVDD</sub> (mA)	I <sub>DVDD</sub> (mA)	I <sub>IOVDD</sub> (mA)	TOTAL POWER (W)
Default	After reset, with a full-scale input signal to both channels	346	354	188	512	2.66
GBL PDN = 1	The device is in a complete power-down state	3	6	21	127	0.2
GBL PDN = 0, PDN ADC CHx = 1 (x = A or B)	The ADC of one channel is powered down	284	221	130	461	2.05
GBL PDN = 0, PDN BUFF CHx = 1 (x = A or B)	The input buffer of one channel is powered down	270	352	188	516	2.43
GBL PDN = 0, PDN ADC CHx = 1, PDN BUFF CHx = 1 (x = A or B)	The ADC and input buffer of one channel are powered down	206	220	129	465	1.82
GBL PDN = 0, PDN ADC CHx = 1, PDN BUFF CHx = 1 (x = A and B)	The ADC and input buffer of both channels are powered down	64	84	67	389	0.93



#### 8.4 Device Functional Modes

### 8.4.1 Device Configuration

The ADS54J69 can be configured by using a serial programming interface, as described in the *Serial Interface* section. In addition, the device has one dedicated parallel pin (PDN) for controlling the power-down mode.

The ADS54J69 supports a 24-bit (16-bit address, 8-bit data) SPI operation and uses paging (see the *Register Maps* section) to access all register bits.

#### 8.4.1.1 Serial Interface

The ADC has a set of internal registers that can be accessed by the serial interface formed by the SEN (serial interface enable), SCLK (serial interface clock), and SDIN (serial interface data) pins, as shown in Figure 65. Legends used in Figure 65 are explained in Table 6. Serially shifting bits into the device is enabled when SEN is low. Serial data on SDIN are latched at every SCLK rising edge when SEN is active (low). The interface can function with SCLK frequencies from 2 MHz down to very low speeds (of a few Hertz) and also with a non-50% SCLK duty cycle.

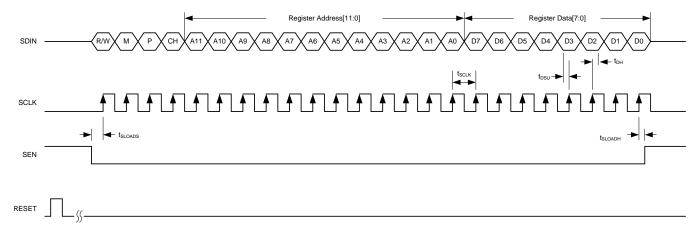


Figure 65. SPI Timing Diagram

**Table 6. SPI Timing Diagram Legend** 

SPI BITS	DESCRIPTION	BIT SETTINGS
R/W	Read/write bit	0 = SPI write 1 = SPI read back
М	SPI bank access	0 = Analog SPI bank (master and ADC pages) 1 = JESD SPI bank (main digital, analog JESD, and digital JESD pages)
Р	JESD page selection bit	0 = Page access 1 = Register access
СН	SPI access for a specific channel of the JESD SPI bank	0 = Channel A 1 = Channel B By default, both channels are being addressed.
A[11:0]	SPI address bits	_
D[7:0]	SPI data bits	_



Table 7 shows the timing requirements for the serial interface signals in Figure 65.

**Table 7. SPI Timing Requirements** 

		MIN	TYP	MAX	UNIT
f <sub>SCLK</sub>	SCLK frequency (equal to 1 / t <sub>SCLK</sub> )	> dc		2	MHz
t <sub>SLOADS</sub>	SEN to SCLK setup time	100			ns
t <sub>SLOADH</sub>	SCLK to SEN hold time	100			ns
t <sub>DSU</sub>	SDIN setup time	100			ns
t <sub>DH</sub>	SDIN hold time	100			ns

## 8.4.1.2 Serial Register Write: Analog Bank

The analog SPI bank contains two pages (the master and ADC page). The internal register of the ADS54J69 analog SPI bank can be programmed by:

- 1. Driving the SEN pin low.
- 2. Initiating a serial interface cycle specifying the page address of the register whose content must be written.
  - Master page: write address 0011h with 80h.
  - ADC page: write address 0011h with 0Fh.
- 3. Writing the register content, as shown in Figure 66. When a page is selected, multiple writes into the same page can be done.

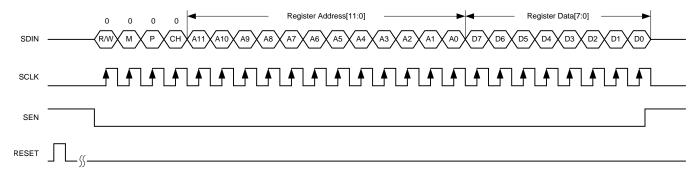


Figure 66. Serial Register Write Timing Diagram



### 8.4.1.3 Serial Register Readout: Analog Bank

The content from one of the two analog banks can be read out by:

- 1. Driving the SEN pin low.
- 2. Selecting the page address of the register whose content must be read.
  - Master page: write address 0011h with 80h.
  - ADC page: write address 0011h with 0Fh.
- 3. Setting the R/W bit to 1 and writing the address to be read back.
- 4. Reading back the register content on the SDOUT pin, as shown in Figure 67. When a page is selected, multiple read backs from the same page can be done.

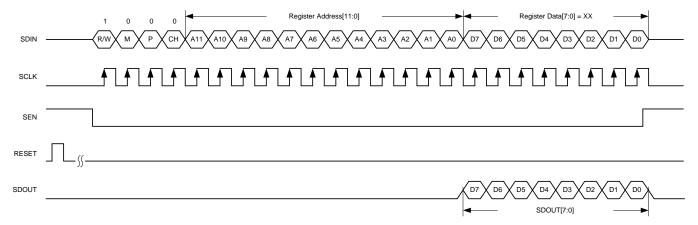


Figure 67. Serial Register Read Timing Diagram

#### 8.4.1.4 JESD Bank SPI Page Selection

The JESD SPI bank contains four pages (main digital, digital, and analog JESD pages). The individual pages can be selected by:

- 1. Driving the SEN pin low.
- 2. Setting the M bit to 1 and specifying the page with two register writes. Note that the P bit must be set to 0, as shown in Figure 68.
  - Write address 4003h with 00h (LSB byte of page address).
  - Write address 4004h with the MSB byte of the page address.
    - For the main digital page: write address 4004h with 68h.
    - For the digital JESD page: write address 4004h with 69h.
    - For the analog JESD page: write address 4004h with 6Ah.

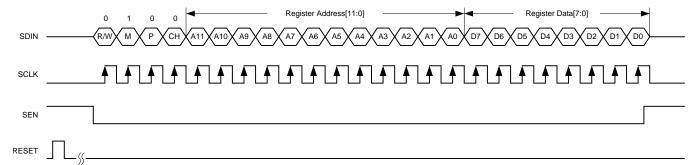


Figure 68. SPI Page Selection



### 8.4.1.5 Serial Register Write: JESD Bank

The ADS54J69 is a dual-channel device and the JESD204B portion is configured individually for each channel by using the CH bit. Note that the P bit must be set to 1 for register writes.

- 1. Drive the SEN pin low.
- 2. Select the JESD bank page. Note that the M bit = 1 and the P bit = 0.
  - Write address 4003h with 00h.
  - If separate control for both channels is desired, write address 4005h with 01h.
  - For the main digital page: write address 4004h with 68h.
  - For the digital JESD page: write address 4004h with 69h.
  - For the analog JESD page: write address 4004h with 6Ah.
- 3. Set the M and P bits to 1, select channel A (CH = 0) or channel B (CH = 1), and write the register content as shown in Figure 69. When a page is selected, multiple writes into the same page can be done.

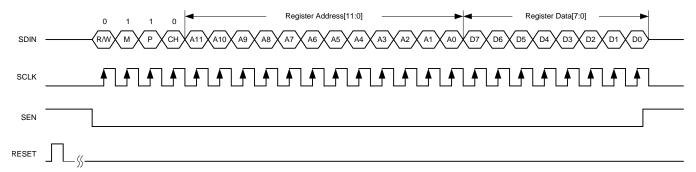


Figure 69. JESD Serial Register Write Timing Diagram

#### 8.4.1.5.1 Individual Channel Programming

By default, register writes are applied to both channels. To enable individual channel writes, write address 4005h with 01h (default is 00h).

#### 8.4.1.6 Serial Register Readout: JESD Bank

The content from one of the pages of the JESD bank can be read out by:

- 1. Driving the SEN pin low.
- 2. Select the JESD bank page. Note that the M bit = 1 and the P bit = 0.
  - Write address 4003h with 00h.
  - If separate control for both channels is desired, write address 4005h with 01h.
  - For the main digital page: write address 4004h with 68h.
  - For the digital JESD page: write address 4004h with 69h.
  - For the analog JESD page: write address 4004h with 6Ah.
- 3. Setting the R/W, M, and P bits to 1, selecting channel A or channel B, and writing the address to be read back.
- 4. Reading back the register content on the SDOUT pin; see Figure 70. When a page is selected, multiple read backs from the same page can be done.



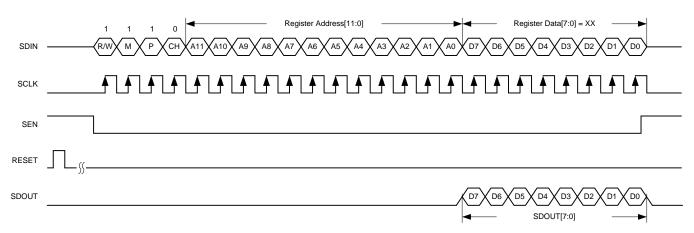


Figure 70. JESD Serial Register Read Timing Diagram

#### 8.4.2 JESD204B Interface

The ADS54J69 supports device subclass 1 with a maximum output data rate of 10.0 Gbps for each serial transmitter.

An external SYSREF signal is used to align all internal clock phases and the local multi-frame clock to a specific sampling clock edge, allowing synchronization of multiple devices in a system and minimizing timing and alignment uncertainty. The SYNC input is used to control the JESD204B SERDES blocks.

Depending on the ADC output data rate, the JESD204B output interface can be operated with either two or four active lanes (out of total 8 lanes), as shown in Figure 71. The JESD204B setup and configuration of the frame assembly parameters is controlled via the SPI interface.

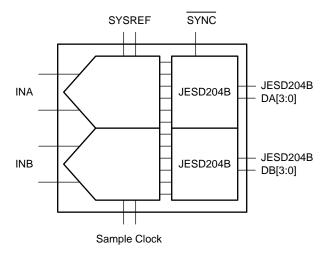


Figure 71. ADS54J69 Block Diagram



The JESD204B transmitter block shown in Figure 72 consists of the transport layer, the data scrambler, and the link layer. The transport layer maps the ADC output data into the selected JESD204B frame data format. The link layer performs the 8b/10b data encoding as well as the synchronization and initial lane alignment using the SYNC input signal. Optionally, data from the transport layer can be scrambled.

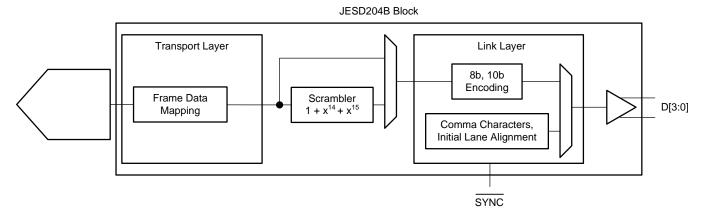


Figure 72. JESD204B Transmitter Block

# 8.4.2.1 JESD204B Initial Lane Alignment (ILA)

The initial lane alignment process is started when the receiving device de-asserts the SYNC signal, as shown in Figure 73. When a logic low is detected on the SYNC input pin, the ADS54J69 starts transmitting comma (K28.5) characters to establish a code group synchronization.

When synchronization is complete, the receiving device asserts the SYNC signal and the ADS54J69 starts the initial lane alignment sequence with the next local multi-frame clock boundary. The ADS54J69 transmits four multi-frames, each containing K frames (K is SPI programmable). Each of the multi-frames contains the frame start and end symbols and the second multi-frame also contains the JESD204 link configuration data.

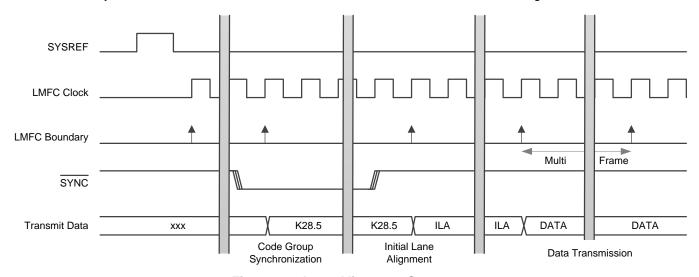


Figure 73. Lane Alignment Sequence

### 8.4.2.2 JESD204B Test Patterns

There are three different test patterns available in the transport layer of the JESD204B interface. The ADS54J69 supports a clock output, encoded, and a PRBS (2<sup>15</sup> – 1) pattern. These test patterns can be enabled via an SPI register write and are located in the JESD digital page of the JESD bank.



#### 8.4.2.3 JESD204B Frame

The JESD204B standard defines the following parameters:

- L is the number of lanes per link
- M is the number of converters per device
- F is the number of octets per frame clock period, per lane
- S is the number of samples per frame per converter

## 8.4.2.4 JESD204B Frame Assembly with Decimation

Table 8 lists the available JESD204B formats and interface rate at maximum sampling frequency. At lower sampling frequencies, interface rates scale down proportionally.

Figure 74 shows the detailed frame assembly for the decimated output.

**Table 8. Interface Rates with Decimation Filter** 

L	М	F	s	JESD MODE REGISTER BIT	JESD PLL MODE SETTING	DECIMATION	MAX ADC OUTPUT RATE (MSPS)	MAX f <sub>SERDES</sub> (Gbps)
4	2	2	2	001	20x	2X	500	5.0
2	2	4	2	010	40x	2X	500	10.0
				· 	·			

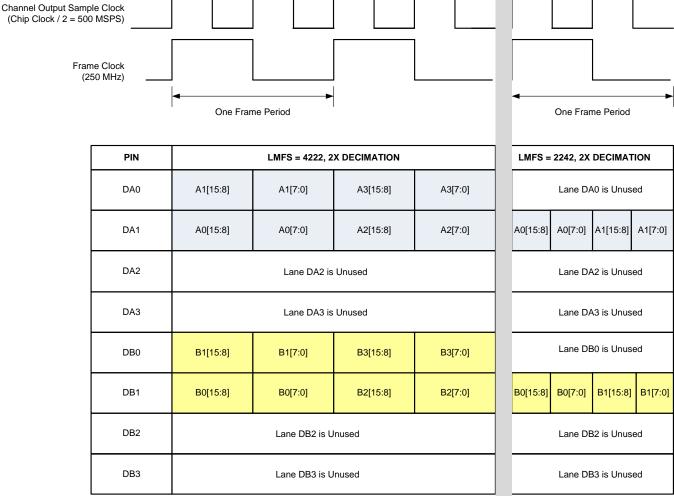


Figure 74. Frame Assembly with Decimation Filter



Note that after power-up, the JESD output bus must be reordered to obtain correct link parameters in the ILA sequence. Table 9 shows the required register writes to reorder the JESD output bus.

L	M	F	s	DECIMATION	JESD PLL MODE (In JESD Analog Page)	JESD MODE REGISTER BIT (In JESD Digital Page)	DA_BUS_REORDER REGISTER BIT (In JESD Digital Page)	DB_BUS_REORDER REGISTER BIT (In JESD Digital Page)	REGISTER 52 (In Main Digital Page)	REGISTER 72 (In Main Digital Page)
4	2	2	2	2X	00h	01h	0Ah	0Ah	80h	08h
2	2	4	2	2X	10h	02h	0Ah	0Ah	80h	08h

#### 8.4.2.4.1 JESD Transmitter Interface

Each of the 10.0-Gbps SERDES JESD transmitter outputs requires ac-coupling between the transmitter and receiver. The differential pair must be terminated with  $100-\Omega$  resistors as close to the receiving device as possible to avoid unwanted reflections and signal degradation, as shown in Figure 75.

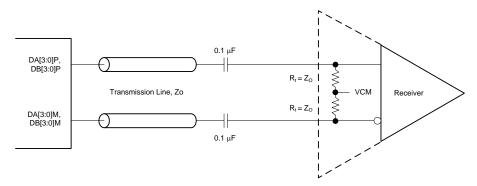


Figure 75. Output Connection to Receiver



### 8.4.2.4.2 Eye Diagrams

Figure 76 to Figure 79 show the serial output eye diagrams of the ADS54J69 at 5.0 Gbps and 10 Gbps with default and increased output voltage swing against the JESD204B mask.

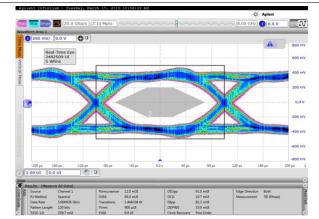


Figure 76. Eye Diagram at 5-Gbps Bit Rate with Default Output Swing

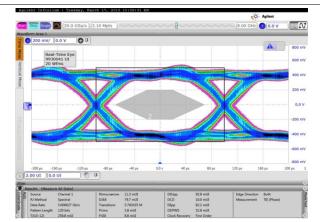


Figure 77. Eye Diagram at 5-Gbps Bit Rate with Increased Output Swing

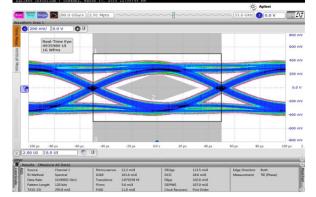


Figure 78. Eye Diagram at 10-Gbps Bit Rate with Default Output Swing

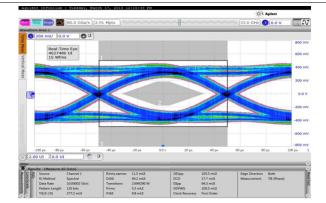


Figure 79. Eye Diagram at 10-Gbps Bit Rate with Increased Output Swing



### 8.5 Register Maps

Figure 80 shows a conceptual diagram of the serial registers.

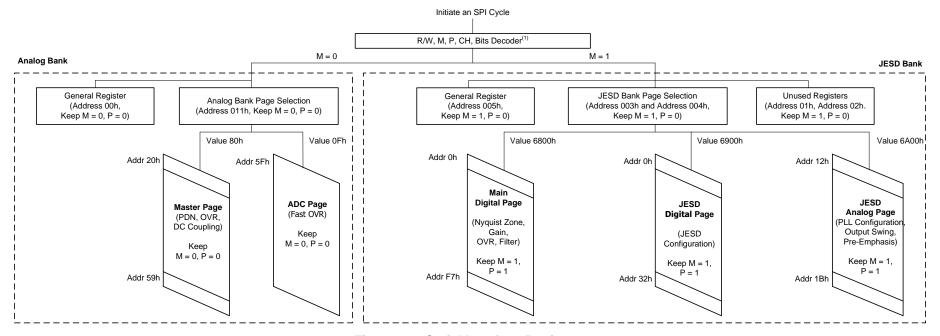


Figure 80. Serial Interface Registers

## 8.5.1 Detailed Register Info

The ADS54J69 contains two main SPI banks: the analog SPI bank and the digital SPI bank. The analog SPI bank gives access to the ADC analog blocks and the JESD SPI bank controls the digital features and anything related to the JESD204B serial interface. The analog SPI bank is divided into two pages (master and ADC) and the JESD SPI bank is divided into three pages (main digital, JESD digital, and JESD analog). Table 10 lists a register map for the ADS54J69.



# **Register Maps (continued)**

# Table 10. Register Map

REGISTER ADDRESS	REGISTER DATA										
A[11:0] (Hex)	7	6	5	4	3	2	1	0			
GENERAL REGIST	ΓERS										
0	RESET	0	0	0	0	0	0	RESET			
3			•	JESD BANK P	AGE SEL[7:0]						
4				JESD BANK PA	AGE SEL[15:8]						
5	0	0	0	0	0	0	0	DISABLE BROADCAST			
11				ANALOG BAN	IK PAGE SEL						
MASTER PAGE (8	0h)										
20		PDN A	DC CHA			PDN	ADC CHB				
21	PDN BUF	FER CHB	PDN BUF	FER CHA	0	0	0	0			
23		PDN A	DC CHA			PDN	ADC CHB				
24	PDN BUF	FER CHB	PDN BUF	FER CHA	0	0	0	0			
26	GLOBAL PDN	OVERRIDE PDN PIN	PDN MASK SEL	0	0	0	0	0			
4F	0	0	0	0	0	0	0	EN INPUT DC COUPLING			
53	0	MASK SYSREF	0	0	0	0	EN SYSREF DC COUPLING	SET SYSREF			
54	ENABLE MANUAL SYSREF	0	0	0	0	0	0	0			
55	0	0	0	PDN MASK	0	0	0	0			
59	FOVR CHB	0	ALWAYS WRITE 1	0	0	0	0	0			
ADC PAGE (0Fh)											
5F				FOVR THRES	HOLD PROG						
MAIN DIGITAL PA	GE (6800h)										
0	0	0	0	0	0	0	0	PULSE RESET			
41	0	0	0	DECFIL MODE[3]	0		DECFIL MODE[2:0]				
42	0	0	0	0	0		NYQUIST ZONE				
43	0	0	0	0	0	0	0	FORMAT SEL			
44	0				DIGITAL GAIN						
4B	0	0	FORMAT EN	0	0	0	0	0			
MAIN DIGITAL PA	GE (6800h) (continue	d)	•								



# **Register Maps (continued)**

Table 10. Register Map (continued)

REGISTER ADDRESS				REGIST	ER DATA			
A[11:0] (Hex)	7	6	5	4	3	2	1	0
4D	0	0	0	0	DEC MODE EN	0	0	0
4E	CTRL NYQUIST	0	0	0	0	0	0	0
52	ALWAYS WRITE 1	0	0	0	0	0	0	DIG GAIN EN
72	0	0	0	0	ALWAYS WRITE 1	0	0	0
AB	0	0	0	0	0	0	0	LSB SEL EN
AD	0	0	0	0	0	0	LSB S	ELECT
F7	0	0	0	0	0	0	0	DIG RESET
JESD DIGITAL PA	GE (6900h)							
0	CTRL K	0	0	TESTMODE EN	FLIP ADC DATA	LANE ALIGN	FRAME ALIGN	TX LINK DIS
1	SYNC REG	SYNC REG EN	0	0	0		JESD MODE	
2	LIN	IK LAYER TESTMOI	DE	LINK LAYER RPAT	LMFC MASK RESET	0	0	0
3	FORCE LMFC COUNT			LMFC COUNT INIT			RELEASE ILANE SEQ	
5	SCRAMBLE EN	0	0	0	0	0	0	0
6	0	0	0		FRAME	ES PER MULTI FRA	ME (K)	
7	0	0	0	0	SUBCLASS	0	0	0
31				DA_BUS_R	EORDER[7:0]			
32				DB_BUS_R	EORDER[7:0]			
JESD ANALOG PA	AGE (6A00h)							
12	SEL EMP LANE 1 0 0							
13		0	0					
14		0	0					
15	SEL EMP LANE 3						0	0
16	0	0	0	0	0	0	JESD PL	L MODE
1A	0	0	0	0	0	0	FOVR CHA	0
1B		JESD SWING		0	FOVR CHA EN	0	0	0



### 8.5.2 Example Register Writes

This section provides three different example register writes. Table 11 describes a global power-down register write, Table 12 describes the register writes to enable the high-pass filter in the default four-lane output mode (LMFS = 4222), and Table 13 describes the register writes to enable the high-pass filter in the two-lane output mode (LMFS = 2242).

Note that by default after reset, the low-pass filter and four-lane output mode are enabled and register writes are applied to both channels together.

**Table 11. Global Power-Down** 

ADDRESS (Hex) DATA (Hex)		COMMENT			
11h	80h	Set the master page			
26h C0h		Set the global power-down			

Table 12. Selecting 2X Decimation with Four-Lane Mode (LMFS = 4222)

ADDRESS (Hex)	DATA (Hex)	COMMENT				
4-004h	68h	Select the main digital page (6900h)				
4-003h	00h	Select the main digital page (6800h)				
6-041h	16h	Set decimate-by-2 (high-pass filter)				
6-04Dh	08h	Enable decimation filter control				
6-072h	08h	Enable the ALWAYS WRITE 1 register bit (for output bus reorder)				
6-052h	80h	Enable the ALWAYS WRITE 1 register bit (for output bus reorder)				
6-000h	01h	Pulse the PULSE RESET register bit so that registers programmed in the main				
6-000h	00h	digital page (6800h) become effective.				
4-004h	69h	Calcat the IECD digital name (6000h)				
4-003h	00h	Select the JESD digital page (6900h)				
6-031h	0Ah	Output bus reorder for channel A				
6-032h	0Ah	Output bus reorder for channel B				
6-001h	01h	JESD filter mode + 4-lanes output selection				

Table 13. Selecting 2X Decimation with Two-Lane Mode (LMFS = 2242)

ADDRESS (Hex)	DATA (Hex)	COMMENT		
4-004h	68h	Select the main digital page (6900h)		
4-003h	00h	Select the main digital page (6800h)		
6-041h	16h	Set decimate-by-2 (high-pass filter)		
6-04Dh	08h	Enable decimation filter control		
6-072h	08h	Set the ALWAYS WRITE 1 register bit (for output bus reorder)		
6-052h	80h	Set the ALWAYS WRITE 1 register bit (for output bus reorder)		
6-000h	01h	Pulse the PULSE RESET register bit so that registers programmed in the main		
6-000h	00h	digital page (6800h) become effective.		
4-004h	69h	Coloret the JECD digital page (COOOL)		
4-003h	00h	Select the JESD digital page (6900h)		
6-031h	0Ah	Output bus reorder for channel A		
6-032h	0Ah	Output bus reorder for channel B		
6-001h	02h	JESD filter mode + 2-lanes output selection		
4-004h	6Ah	Coloret the JECD analog page (CAOOL)		
4-003h	00h	Select the JESD analog page (6A00h)		
6-016h	02h	JESD PLL MODE 40x selection in the analog page		



### 8.5.3 Register Descriptions

## 8.5.3.1 General Registers

### 8.5.3.1.1 Register 0h (address = 0h)

## Figure 81. Register 0h

7	6	5	4	3	2	1	0
RESET	0	0	0	0	0	0	RESET
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h

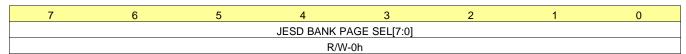
LEGEND: W = Write only; -n = value after reset

## Table 14. Register 0h Field Descriptions

Bit	Field	Туре	Reset	Description
7	RESET	W	0h	0 = Normal operation 1 = Internal software reset, clears back to 0
6-1	0	W	0h	Must write 0
0	RESET	W	0h	0 = Normal operation 1 = Internal software reset, clears back to 0

### 8.5.3.1.2 Register 3h (address = 3h)

### Figure 82. Register 3h



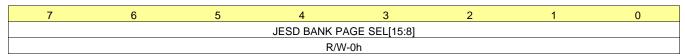
LEGEND: R/W = Read/Write; -n = value after reset

### Table 15. Register 3h Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	JESD BANK PAGE SEL[7:0]	R/W	Oh	Program these bits to access the desired page in the JESD bank.  6800h = Main digital page selected  6900h = JESD digital page selected  6A00h = JESD analog page selected

### 8.5.3.1.3 Register 4h (address = 4h)

## Figure 83. Register 4h



LEGEND: R/W = Read/Write; -n = value after reset

## Table 16. Register 4h Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	JESD BANK PAGE SEL[15:8]	R/W	Oh	Program these bits to access the desired page in the JESD bank.  6800h = Main digital page selected  6900h = JESD digital page selected  6A00h = JESD analog page selected



### 8.5.3.1.4 Register 5h (address = 5h)

## Figure 84. Register 5h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	DISABLE BROADCAST
W-0h	R/W-0h						

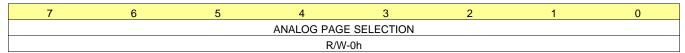
LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

### **Table 17. Register 5h Field Descriptions**

Bit	Field	Туре	Reset	Description
7-1	0	W	0h	Must write 0
0	DISABLE BROADCAST	R/W		0 = Normal operation; channel A and B are programmed as a pair 1 = Channel A and B can be individually programmed based on the CH bit (keep CH = 0 for channel A, CH = 1 for channel B).

## 8.5.3.1.5 Register 11h (address = 11h)

### Figure 85. Register 11h



LEGEND: R/W = Read/Write; -n = value after reset

## Table 18. Register 11h Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	ANALOG BANK PAGE SEL	R/W	Oh	Program these bits to access the desired page in the analog bank.  Master page = 80h  ADC page = 0Fh

### 8.5.3.2 Master Page (080h) Registers

## 8.5.3.2.1 Register 20h (address = 20h), Master Page (080h)

## Figure 86. Register 20h

7	6	5	4	3	2	1	0	
	PDN AI	DC CHA		PDN ADC CHB				
	R/V	V-0h			R/W	/-0h		

LEGEND: R/W = Read/Write; -n = value after reset

## Table 19. Registers 20h Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	PDN ADC CHA	R/W	0h	There are two power-down masks that are controlled via the
3-0	PDN ADC CHB	R/W	0h	PDN mask register bit in address 55h. Power-down mask 1 or mask 2 are selected via register bit 5 in address 26h.  Power-down mask 1: addresses 20h and 21h.  Power-down mask 2: addresses 23h and 24h.  0Fh = Power-down CHB only.  F0h = Power-down CHA only.  FFh = Power-down both.



## 8.5.3.2.2 Register 21h (address = 21h), Master Page (080h)

## Figure 87. Register 21h

7	6	5	4	3	2	1	0
PDN BUF	FER CHB	PDN BUF	FER CHA	0	0	0	0
R/V	V-0h	R/W-0h		W-0h	W-0h	W-0h	W-0h

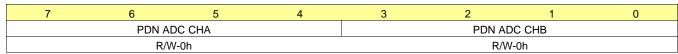
LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 20. Register 21h Field Descriptions

Bit	Field	Туре	Reset	Description
7-6	PDN BUFFER CHB	R/W	0h	There are two power-down masks that are controlled via the
5-4	PDN BUFFER CHA	R/W	Oh	PDN mask register bit in address 55h. Power-down mask 1 or mask 2 are selected via register address 26h, bit 5.  Power-down mask 1: addresses 20h and 21h.  Power-down mask 2: addresses 23h and 24h.  There are two buffers per channel. One buffer drives two ADC cores.  PDN BUFFER CHx:  00 = Both buffers of a channel are active.  11 = Both buffers are powered down.  01–10 = Do not use.
3-0	0	W	0h	Must write 0

## 8.5.3.2.3 Register 23h (address = 23h), Master Page (080h)

## Figure 88. Register 23h



LEGEND: R/W = Read/Write; -n = value after reset

## Table 21. Register 23h Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	PDN ADC CHA	R/W	0h	There are two power-down masks that are controlled via the
3-0	PDN ADC CHB	R/W	Oh	PDN mask register bit in address 55h. Power-down mask 1 or mask 2 are selected via register address 26h, bit 5. Power-down mask 1: addresses 20h and 21h. Power-down mask 2: addresses 23h and 24h.  0Fh = Power-down CHB only. F0h = Power-down CHA only. FFh = Power-down both.



## 8.5.3.2.4 Register 24h (address = 24h), Master Page (080h)

## Figure 89. Register 24h

7	6	5	4	3	2	1	0
PDN BUFFE	R CHB	PDN BUF	PDN BUFFER CHA		0	0	0
R/W-0	)h	R/W	R/W-0h		W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 22. Register 24h Field Descriptions

Bit	Field	Туре	Reset	Description
7-6	PDN BUFFER CHB	R/W	0h	There are two power-down masks that are controlled via the
5-4	PDN BUFFER CHA	R/W	Oh	PDN mask register bit in address 55h. Power-down mask 1 or mask 2 are selected via register address 26h, bit 5. Power-down mask 1: addresses 20h and 21h. Power-down mask 2: addresses 23h and 24h. Power-down mask 2: addresses 23h and 24h. There are two buffers per channel. One buffer drives two ADC cores. PDN BUFFER CHx: 00 = Both buffers of a channel are active. 11 = Both buffers are powered down. 01–10 = Do not use.
3-0	0	W	0h	Must write 0



## 8.5.3.2.5 Register 26h (address = 26h), Master Page (080h)

### Figure 90. Register 26h

7	6	5	4	3	2	1	0
GLOBAL PDN	OVERRIDE PDN PIN	PDN MASK SEL	0	0	0	0	0
R/W-0h	R/W-0h	R/W-0h	W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

### Table 23. Register 26h Field Descriptions

Bit	Field	Туре	Reset	Description
7	GLOBAL PDN	R/W	0h	Bit 6 (OVERRIDE PDN PIN) must be set before this bit can be programmed.  0 = Normal operation  1 = Global power-down via the SPI
6	OVERRIDE PDN PIN	R/W	0h	This bit ignores the power-down pin control.  0 = Normal operation  1 = Ignores inputs on the power-down pin
5	PDN MASK SEL	R/W	0h	This bit selects power-down mask 1 or mask 2.  0 = Power-down mask 1  1 = Power-down mask 2
4-0	0	W	0h	Must write 0

### 8.5.3.2.6 Register 39h (address = 39h), Master Page (080h)

### Figure 91. Register 39h

7	6	5	4	3	2	1	0
PERF MOI	DE[1:0]	0	0	0	0	0	0
R/W-0	)h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

### Table 24. Register 39h Field Descriptions

Bit	Field	Туре	Reset	Description
7-6	PERF MODE[1:0]	R/W	Oh	Set all four PERF MODE[3:0] bits together. Bits are located in register address 39h, 3Ah, and 56h in the master page.
5-0	0	W	0h	Must write 0

### 8.5.3.2.7 Register 3Ah (address = 3Ah), Master Page (080h)

## Figure 92. Register 3Ah

7	6	5	4	3	2	1	0
0	PERF MODE[2]	0	0	0	0	0	0
W-0h	R/W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 25. Register 3Ah Field Descriptions

Bit	Field	Туре	Reset	Description
7	0	W	0h	Must write 0
6	PERF MODE[2]	R/W	0h	Set all four PERF MODE[3:0] bits together. Bits are located in register address 39h, 3Ah, and 56h in the master page.
5-0	0	W	0h	Must write 0



### 8.5.3.2.8 Register 4Fh (address = 4Fh), Master Page (080h)

### Figure 93. Register 4Fh

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	EN INPUT DC COUPLING
W-0h	R/W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

# Table 26. Register 4Fh Field Descriptions

Bit	Field	Туре	Reset	Description
7-1	0	W	0h	Must write 0
0	EN INPUT DC COUPLING	R/W	Oh	Enables dc-coupling between the analog inputs and driver by changing the internal biasing resistor between the analog inputs and VCM from 600 $\Omega$ to 5 k $\Omega$ .  0 = Disable dc-coupling support 1 = Enable dc-coupling support

### 8.5.3.2.9 Register 53h (address = 53h), Master Page (080h)

## Figure 94. Register 53h

7	6	5	4	3	2	1	0
0	MASK SYSREF	0	0	0	0	EN SYSREF DC COUPLING	SET SYSREF
W-0h	R/W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 27. Register 53h Field Descriptions

Bit	Field	Туре	Reset	Description
7	0	W	0h	Must write 0
6	MASK SYSREF	R/W	0h	0 = Normal operation 1 = Ignores the SYSREF input
5-2	0	W	0h	Must write 0
1	EN SYSREF DC COUPLING	R/W	0h	Enables a higher common-mode voltage input on the SYSREF signal (up to 1.6 V).  0 = Normal operation  1 = Enables a higher SYSREF common-mode voltage support
0	SET SYSREF	R/W	0h	0 = Set SYSREF low 1 = Set SYSREF high

### 8.5.3.2.10 Register 54h (address = 54h), Master Page (080h)

## Figure 95. Register 54h

7	6	5	4	3	2	1	0
ENABLE MANUAL SYSREF	0	0	0	0	0	0	0
R/W-0h	W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

### Table 28. Register 54h Field Descriptions

Bit	Field	Туре	Reset	Description
7	ENABLE MANUAL SYSREF	R/W	0h	This bit enables manual SYSREF
6-0	0	W	0h	Must write 0



### 8.5.3.2.11 Register 55h (address = 55h), Master Page (080h)

### Figure 96. Register 55h

7	6	5	4	3	2	1	0
0	0	0	PDN MASK	0	0	0	0
W-0h	W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 29. Register 55h Field Descriptions

Bit	Field	Туре	Reset	Description
7-5	0	W	0h	Must write 0
4	PDN MASK	R/W	Oh	This bit enables power-down via a register bit.  0 = Normal operation  1 = Power-down is enabled by powering down internal blocks as specified in the selected power-down mask
3-0	0	W	0h	Must write 0

## 8.5.3.2.12 Register 56h (address = 56h), Master Page (080h)

## Figure 97. Register 56h

7	6	5	4	3	2	1	0
0	0	0	0	0	PERF MODE[3]	0	0
W-0h	W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: W = Write only; -n = value after reset

## Table 30. Register 56h Field Descriptions

Bit	Field	Туре	Reset	Description
7-3	0	W	0h	Must write 0
2	PERF MODE[3]	W	0h	Set all four PERF MODE[3:0] bits together. Bits are located in register address 39h, 3Ah, and 56h in the master page.
1-0	0	W	0h	Must write 0

## 8.5.3.2.13 Register 59h (address = 59h), Master Page (080h)

## Figure 98. Register 59h

7	6	5	4	3	2	1	0
FOVR CHB	0	ALWAYS WRITE 1	0	0	0	0	0
W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 31. Register 59h Field Descriptions

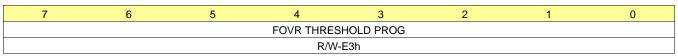
Bit	Field	Туре	Reset	Description
7	FOVR CHB	W	0h	Outputs the FOVR signal for channel B on the SDOUT pin.  0 = Normal operation  1 = Outputs FOVR on the SDOUT pin
6	0	W	0h	Must write 0
5	ALWAYS WRITE 1	R/W	0h	Must write 1
4-0	0	W	0h	Must write 0



## 8.5.3.3 ADC Page (0Fh) Registers

## 8.5.3.3.1 Registers 5F (addresses = 5F), ADC Page (0Fh)

# Figure 99. Register 5F



LEGEND: R/W = Read/Write; -n = value after reset

## Table 32. Registers 5F Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	FOVR THRESHOLD PROG	R/W		Program the fast OVR thresholds together for channel A and B, as described in the <i>Overrange Indication</i> section.



## 8.5.3.4 Main Digital Page (6800h) Registers

## 8.5.3.4.1 Register 0h (address = 0h), Main Digital Page (6800h)

## Figure 100. Register 0h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	PULSE RESET
W-0h	R/W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 33. Register 0h Field Descriptions

Bit	Field	Туре	Reset	Description
7-1	0	W	0h	Must write 0
0	PULSE RESET	R/W	Oh	Must be pulsed after power-up or after configuring registers in the main digital page of the JESD bank. Any register bits in the main digital page (6800h) take effect only after this bit is pulsed; see the <i>Start-Up Sequence</i> section for the correct sequence. $0 = \text{Normal operation}$ $0 \rightarrow 1 \rightarrow 0 = \text{Bit is pulsed}$

## 8.5.3.4.2 Register 41h (address = 41h), Main Digital Page (6800h)

## Figure 101. Register 41h

7	6	5	4	3	2	2 1	
0	0	0	DECFIL MODE[3]	0	DECFIL MODE[2:0]		
W-0h	W-0h	W-0h	R/W-0h	W-0h		R/W-0h	

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 34. Register 41h Field Descriptions

Bit	Field	Туре	Reset	Description
7-5	0	W	0h	Must write 0
4	DECFIL MODE[3]	R/W	0h	Refer Table 35.
3	0	W	0h	Must write 0
2-0	DECFIL MODE[2:0]	R/W	2h	These bits select the decimation filter mode. Table 35 lists the bit settings.  Register bit DEC MODE EN (register 4Dh, bit 3) must also be enabled.

## Table 35. DECFIL MODE Bit Settings

DEC MODE EN (REGISTER 4Dh, BIT 3)	BITS (4, 2-0)	FILTER MODE	DECIMATION
0	XXXX	Low-pass filter	2X
1	1010	Low-pass filter	2X
1	1110	High-pass filter	2X
1	Others	Do not use	_



### 8.5.3.4.3 Register 42h (address = 42h), Main Digital Page (6800h)

### Figure 102. Register 42h

7	6	5	4	3	2	1	0	
0	0	0	0	0	NYQUIST ZONE			
W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h			

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

### Table 36. Register 42h Field Descriptions

Bit	Field	Туре	Reset	Description
7-3	0	W	0h	Must write 0
2-0	NYQUIST ZONE	R/W	Oh	The Nyquist zone must be selected for proper interleaving correction. Here Nyquist refers to Device Clock/2. For 1 GSPS Device clock, Nyquist frequency is 500 MHz. Also set register bit CTRL NYQUIST (4Eh, bit 7).  000 = 1st Nyquist zone (0 MHz to 500 MHz)  001 = 2nd Nyquist zone (500 MHz to 1000 MHz)  010 = 3rd Nyquist zone (1000 MHz to 1500 MHz)  All others = Not used

### 8.5.3.4.4 Register 43h (address = 43h), Main Digital Page (6800h)

## Figure 103. Register 43h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	FORMAT SEL
W-0h	R/W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 37. Register 43h Field Descriptions

Bit	Field	Туре	Reset	Description
7-1	0	W	0h	Must write 0
0	FORMAT SEL	R/W	0h	Changes the output format. Set the FORMAT EN bit (register 4Bh, bit 5) to enable control using this bit.  0 = Twos complement 1 = Offset binary

### 8.5.3.4.5 Register 44h (address = 44h), Main Digital Page (6800h)

### Figure 104. Register 44h

7	6	5	4	3	2	1	0
0				DIGITAL GAIN			
R/W-0h				R/W-0h			

LEGEND: R/W = Read/Write; -n = value after reset

### Table 38. Register 44h Field Descriptions

Bit	Field	Туре	Reset	Description
7	0	R/W	0h	Must write 0
6-0	DIGITAL GAIN	R/W	0h	Digital gain setting. Digital gain must be enabled (register 52h, bit 0).  Gain in dB = 20log (digital gain / 32).  7Fh = 127, equals digital gain of 9.5 dB.



## 8.5.3.4.6 Register 4Bh (address = 4Bh), Main Digital Page (6800h)

## Figure 105. Register 4Bh

7	6	5	4	3	2	1	0
0	0	FORMAT EN	0	0	0	0	0
W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 39. Register 4Bh Field Descriptions

Bit	Field	Туре	Reset	Description
7-6	0	W	0h	Must write 0
5	FORMAT EN	R/W	Oh	This bit enables control for data format selection using the FORMAT SEL register bit.  0 = Default, output is in twos complement format  1 = Output is in offset binary format after the FORMAT SEL bit is set
4-0	0	W	0h	Must write 0

## 8.5.3.4.7 Register 4Dh (address = 4Dh), Main Digital Page (6800h)

## Figure 106. Register 4Dh

7	6	5	4	3	2	1	0
0	0	0	0	DEC MOD EN	0	0	0
W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 40. Register 4Dh Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	0	W	0h	Must write 0
3	DEC MOD EN	R/W	Oh	This bit enables control of decimation filter mode via the DECFIL MODE[3:0] register bits.  0 = Default  1 = Decimation modes control is enabled
2-0	0	W	0h	Must write 0



### 8.5.3.4.8 Register 4Eh (address = 4Eh), Main Digital Page (6800h)

### Figure 107. Register 4Eh

7	6	5	4	3	2	1	0
CTRL NYQUIST	0	0	0	0	0	0	0
R/W-0h	W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

### Table 41. Register 4Eh Field Descriptions

Bit	Field	Туре	Reset	Description
7	CTRL NYQUIST	R/W	0h	This bit enables selecting the Nyquist zone using register 42h, bits 2-0.  0 = Selection disabled 1 = Selection enabled
6-0	0	W	0h	Must write 0

## 8.5.3.4.9 Register 52h (address = 52h), Main Digital Page (6800h)

## Figure 108. Register 52h

7	6	5	4	3	2	1	0
ALWAYS WRITE 1	0	0	0	0	0	0	DIG GAIN EN
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 42. Register 52h Field Descriptions

Bit	Field	Туре	Reset	Description
7	ALWAYS WRITE 1	W	Oh	This bit enables output bus reorder using the Dx_BUS_REORDER[7:0] bits. Set this bit along with register 72h, bit 3 in the main digital page.
6-1	0	W	0h	Must write 0
0	DIG GAIN EN	R/W	0h	Enables selecting the digital gain for register 44h.  0 = Digital gain disabled  1 = Digital gain enabled

#### 8.5.3.4.10 Register 72h (address = 72h), Main Digital Page (6800h)

## Figure 109. Register 72h

7	6	5	4	3	2	1	0
0	0	0	0	ALWAYS WRITE 1	0	0	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h

LEGEND: W = Write only; -n = value after reset

## Table 43. Register 72h Field Descriptions

Bit	Field	Туре	Reset	Description
7-4	0	W	0h	Must write 0
3	ALWAYS WRITE 1	W	0h	This bit enables output bus reorder using the Dx_BUS_REORDER[7:0] bits. Set this bit along with register 52h, bit 7 in the main digital page.
2-0	0	W	0h	Must write 0



### 8.5.3.4.11 Register ABh (address = ABh), Main Digital Page (6800h)

### Figure 110. Register ABh

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	LSB SEL EN
W-0h	R/W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

### Table 44. Register ABh Field Descriptions

Bit	Field	Туре	Reset	Description
7-1	0	W	0h	Must write 0
0	LSB SEL EN	R/W	Oh	Enables control for the LSB SELECT register bit.  0 = Default  1 = The LSB of the 16-bit ADC data can be programmed as fast OVR using the LSB SELECT bit

## 8.5.3.4.12 Register ADh (address = ADh), Main Digital Page (6800h)

## Figure 111. Register ADh

7	6	5	4	3	2	1 0
0	0	0	0	0	0	LSB SELECT
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

### Table 45. Register ADh Field Descriptions

Bit	Field	Туре	Reset	Description
7-2	0	W	0h	Must write 0
1-0	LSB SELECT	R/W	Oh	Enables output of the FOVR flag instead of the output data LSB. 00 = Output is 16-bit data 11 = Output data LSB is replaced by the FOVR information for each channel

### 8.5.3.4.13 Register F7h (address = F7h), Main Digital Page (6800h)

## Figure 112. Register F7h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	DIG RESET
W-0h							

LEGEND: W = Write only; -n = value after reset

## Table 46. Register F7h Field Descriptions

Bit	Field	Туре	Reset	Description
7-1	0	W	0h	Must write 0
0	DIG RESET	W		Self-clearing reset for the digital block. Does not include the interleaving correction.  0 = Normal operation  1 = Digital reset



## 8.5.3.5 JESD Digital Page (6900h) Registers

## 8.5.3.5.1 Register 0h (address = 0h), JESD Digital Page (6900h)

## Figure 113. Register 0h

7	6	5	4	3	2	1	0
CTRL K	0	0	TESTMODE EN	FLIP ADC DATA	LANE ALIGN	FRAME ALIGN	TX LINK DIS
R/W-0h	W-0h	W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## **Table 47. Register 0h Field Descriptions**

Bit	Field	Туре	Reset	Description
7	CTRL K	R/W	0h	Enable bit for a number of frames per multi-frame.  0 = Default is five frames per multi-frame  1 = Frames per multi-frame can be set in register 06h
6-5	0	W	0h	Must write 0
4	TESTMODE EN	R/W	Oh	This bit generates the long transport layer test pattern mode, as per section 5.1.6.3 of the JESD204B specification.  0 = Test mode disabled  1 = Test mode enabled
3	FLIP ADC DATA	R/W	0h	0 = Normal operation 1 = Output data order is reversed: MSB to LSB
2	LANE ALIGN	R/W	0h	This bit inserts the lane alignment character (K28.3) for the receiver to align to the lane boundary, as per section 5.3.3.5 of the JESD204B specification.  0 = Normal operation 1 = Inserts lane alignment characters
1	FRAME ALIGN	R/W	0h	This bit inserts the lane alignment character (K28.7) for the receiver to align to the lane boundary, as per section 5.3.3.5 of the JESD204B specification.  0 = Normal operation 1 = Inserts frame alignment characters
0	TX LINK DIS	R/W	Oh	This bit disables sending the initial link alignment (ILA) sequence when SYNC is de-asserted.  0 = Normal operation 1 = ILA disabled



## 8.5.3.5.2 Register 1h (address = 1h), JESD Digital Page (6900h)

## Figure 114. Register 1h

7	6	5	4	3	2	2 1 0		
SYNC REG	SYNC REG EN	0	0	0	JESD MODE			
R/W-0h	R/W-0h	W-0h	W-0h	W-0h	R/W-1h			

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 48. Register 1h Field Descriptions

Bit	Field	Туре	Reset	Description
7	SYNC REG	R/W	Oh	Register control for sync request.  0 = Normal operation  1 = ADC output data are replaced with K28.5 characters; the SYNC REG EN register bit must also be set to 1
6	SYNC REG EN	R/W	0h	Enables register control for sync request.  0 = Use the SYNC pin for sync requests  1 = Use the SYNC REG register bit for sync requests
5-3	0	W	0h	Must write 0
2-0	JESD MODE	R/W	1h	These bits select the number of active output lanes. The JESD PLL MODE register bit located in the JESD analog page must also be set accordingly. Active lanes carry serial JESD data whereas inactive lanes don't carry any data.  001 = 20X mode, four active lanes per device (default)  010 = 40X mode, two active lanes per device  All others = Not used

## 8.5.3.5.3 Register 2h (address = 2h), JESD Digital Page (6900h)

## Figure 115. Register 2h

7	6	5 4		3	2	1	0
LINK	LAYER TESTM	1ODE	LINK LAYER RPAT	LMFC MASK RESET	0	0	0
	R/W-0h		R/W-0h	R/W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 49. Register 2h Field Descriptions

Bit	Field	Туре	Reset	Description
7-5	LINK LAYER TESTMODE	R/W	Oh	These bits generate a pattern according to section 5.3.3.8.2 of the JESD204B document.  000 = Normal ADC data  001 = D21.5 (high-frequency jitter pattern)  010 = K28.5 (mixed-frequency jitter pattern)  011 = Repeat initial lane alignment (generates a K28.5 character and continuously repeats lane alignment sequences)  100 = 12-octet RPAT jitter pattern  All others = Not used
4	LINK LAYER RPAT	R/W	0h	This bit changes the running disparity in the modified RPAT pattern test mode (only when the link layer test mode = 100).  0 = Normal operation  1 = Changes disparity
3	LMFC MASK RESET	R/W	0h	Masks the LMFC reset coming to the digital block.  0 = LMFC reset is not masked  1 = Ignore the LMFC reset request
2-0	0	W	0h	Must write 0



### 8.5.3.5.4 Register 3h (address = 3h), JESD Digital Page (6900h)

## Figure 116. Register 3h

7	6	5	4	3	2	1	0
FORCE LMFC COUNT			LMFC COUNT INIT	Г		RELEASE	ILANE SEQ
R/W-0h		R/W-0h					V-0h

LEGEND: R/W = Read/Write; -n = value after reset

## Table 50. Register 3h Field Descriptions

Bit	Field	Туре	Reset	Description
7	FORCE LMFC COUNT	R/W	Oh	This bit forces the LMFC count.  0 = Normal operation  1 = Enables using a different starting value for the LMFC counter
6-2	MASK SYSREF	R/W	Oh	When SYSREF transmits to the digital block, the LMFC count resets to 0 and K28.5 stops transmitting when the LMFC count reaches 31. The initial value that the LMFC count resets to can be set using LMFC COUNT INIT. In this manner, the receiver can be synchronized early because the LANE ALIGNMENT SEQUENCE is received early. The FORCE LMFC COUNT register bit must be enabled.
1-0	RELEASE ILANE SEQ	R/W	Oh	These bits delay the generation of the lane alignment sequence by 0, 1, 2 or 3 multi-frames after the code group synchronization.  00 = 0 01 = 1 10 = 2 11 = 3

## 8.5.3.5.5 Register 5h (address = 5h), JESD Digital Page (6900h)

## Figure 117. Register 5h

7	6	5	4	3	2	1	0
SCRAMBLE EN	0	0	0	0	0	0	0
R/W-Undefined	W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## **Table 51. Register 5h Field Descriptions**

Bit	Field	Туре	Reset	Description
7	SCRAMBLE EN	R/W		Scrambles the enable bit in the JESD204B interface.  0 = Scrambling disabled  1 = Scrambling enabled
6-0	0	W	0h	Must write 0



## 8.5.3.5.6 Register 6h (address = 6h), JESD Digital Page (6900h)

## Figure 118. Register 6h

7	6	5	4	3	2	1	0
0	0	0		FRAME	S PER MULTI FR	AME (K)	
W-0h	W-0h	W-0h			R/W-8h		

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 52. Register 6h Field Descriptions

Bit	Field	Туре	Reset	Description
7-5	0	W	0h	Must write 0
4-0	FRAMES PER MULTI FRAME (K)	R/W	8h	These bits set the number of multi-frames. Actual K is the value in hex + 1 (that is, 0Fh is K = 16).

## 8.5.3.5.7 Register 7h (address = 7h), JESD Digital Page (6900h)

## Figure 119. Register 7h

7	6	5	4	3	2	1	0
0	0	0	0	SUBCLASS	0	0	0
W-0h	W-0h	W-0h	W-0h	R/W-1h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

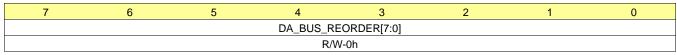
## **Table 53. Register 7h Field Descriptions**

Bit	Field	Туре	Reset	Description
7-4	0	W	0h	Must write 0
3	SUBCLASS	R/W	1h	This bit sets the JESD204B subclass.  000 = Subclass 0 is backward compatible with JESD204A  001 = Subclass 1 deterministic latency using the SYSREF signal
2-0	0	W	0h	Must write 0



### 8.5.3.5.8 Register 31h (address = 31h), JESD Digital Page (6900h)

### Figure 120. Register 31h



LEGEND: R/W = Read/Write; -n = value after reset

## Table 54. Register 31h Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	DA_BUS_REORDER[7:0]	R/W		Use these bits to program output connections between data streams and output lanes in decimate-by-2 mode. Table 12 lists the supported combinations of these bits.

### 8.5.3.5.9 Register 32h (address = 32h), JESD Digital Page (6900h)

## Figure 121. Register 32h

7	6	5	4	3	2	1	0
			DB_BUS_RE	ORDER[7:0]			
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

## Table 55. Register 32h Field Descriptions

Bit	Field	Туре	Reset	Description
7-0	DB_BUS_REORDER[7:0]	R/W	0h	Use these bits to program output connections between data streams and output lanes in decimate-by-2 mode. Table 12 lists the supported combinations of these bits.



## 8.5.3.6 JESD Analog Page (6A00h) Register

### 8.5.3.6.1 Registers 12h-5h (address = 12h-5h), JESD Analog Page (6A00h)

## Figure 122. Register 12h

7	6	5	4	3	2	1	0
	SEL EMP LANE 1						0
	R/W-0h						W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

### Figure 123. Register 13h

7	6	5	4	3	2	1	0
	SEL EMP LANE 0					0	0
	R/W-0h					W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Figure 124. Register 14h

7	6	5	4	3	2	1	0
	SEL EMP LANE 2					0	0
	R/W-0h					W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Figure 125. Register 15h

7	6	5	4	3	2	1	0
	SEL EMP LANE 3					0	0
	R/W-0h				W-0h	W-0h	

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 56. Registers 12h-15h Field Descriptions

Bit	Field	Туре	Reset	Description
7-2	SEL EMP LANE 1, 0, 2, or 3	R/W	Oh	Selects the amount of de-emphasis for the JESD output transmitter. The de-emphasis value in dB is measured as the ratio between the peak value after the signal transition to the settled value of the voltage in one bit period.  000000 = 0 dB  000001 = -1 dB  000011 = -2 dB  000111 = -4.1 dB  001111 = -6.2 dB  011111 = -8.2 dB  111111 = -11.5 dB
1-0	0	W-0h	0h	Must write 0



### 8.5.3.6.2 Register 16h (address = 16h), JESD Analog Page (6A00h)

### Figure 126. Register 16h

7	6	5	4	3	2	1 0
0	0	0	0	0	0	JESD PLL MODE
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 57. Register 16h Field Descriptions

Bit	Field	Туре	Reset	Description
7-2	0	W	0h	Must write 0
1-0	JESD PLL MODE	R/W	Oh	These bits select the JESD PLL multiplication factor and must match the JESD MODE setting.  00 = 20X mode, four active lanes per device  01 = Not used  10 = 40X mode, two active lanes per device  11 = Not used

## 8.5.3.6.3 Register 1Ah (address = 1Ah), JESD Analog Page (6A00h)

## Figure 127. Register 1Ah

7	6	5	4	3	2	1	0
0	0	0	0	0	0	FOVR CHA	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

## Table 58. Register 1Ah Field Descriptions

Bit	Field	Туре	Reset	Description
7-2	0	W	0h	Must write 0
1	FOVR CHA	R/W	Oh	Outputs the FOVR signal for channel A on the PDN pin. FOVR CHA EN (register 1Bh, bit 3) must be enabled.  0 = Normal operation 1 = FOVR on the PDN pin
0	0	W	0h	Must write 0



## 8.5.3.6.4 Register 1Bh (address = 1Bh), JESD Analog Page (6A00h)

### Figure 128. Register 1Bh

7	6	5	4	3	2	1	0
	JESD SWING		0	FOVR CHA EN	0	0	0
	R/W-0h		W-0h	R/W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

#### Table 59. Register 1Bh Field Descriptions

Bit	Field	Туре	Reset	Description
7-5	JESD SWING	R/W	Oh	Selects the output differential amplitude $V_{OD}$ (mV <sub>PP</sub> ) of the JESD transmitter (for all lanes). $0=860~\text{mV}_{PP}$ $1=810~\text{mV}_{PP}$ $2=770~\text{mV}_{PP}$ $3=745~\text{mV}_{PP}$ $4=960~\text{mV}_{PP}$ $5=930~\text{mV}_{PP}$ $6=905~\text{mV}_{PP}$ $7=880~\text{mV}_{PP}$
4	0	W	0h	Must write 0
3	FOVR CHA EN	R/W	0h	Enables overwriting the PDN pin with the FOVR signal from channel A.  0 = Normal operation 1 = PDN is overwritten
2-0	JESD PLL MODE	R/W	0h	Must write 0

# 9 Application and Implementation

#### **NOTE**

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

## 9.1 Application Information

### 9.1.1 Start-Up Sequence

The steps described in Table 60 are the recommended power-up sequence with the ADS54J69 in 20X or 40X mode.



# Table 60. Initialization Sequence

STEP	SEQUENCE	DESCRIPTION	PAGE BEING PROGRAMMED	COMMENT
1	Power-up the device	Bring up IOVDD to 1.15 V before applying power to DVDD. Bring up DVDD to 1.9 V, AVDD to 1.9 V, and AVDD3V to 3.0 V.	_	See the <i>Power Sequencing and Initialization</i> section for power sequence requirements.
		Hardware reset		
		Apply a hardware reset by pulsing pin 48 (low->high->low).	_	A hardware reset clears all registers to their default values.
		Software reset: Register writes equivalent to a hardware reset are:		
	2 Reset the device	Write address 0-000h with 81h.	General register	Reset registers in the ADC page and master page of the analog bank This bit is a self-clearing bit.
2				This bit is a self-clearing bit.
		Write address 4-001h with 00h and address 4-002h with 00h.	Unused page	Clear any unwanted content from the unused pages of the JESD bank.
		Write address 4-003h with 00h and address 4-004h with 68h.	_	Select the main digital page of the JESD bank.
		Write address 6-0F7h with 01h for channel A.		Use the DIG RESET register bit to reset all pages in the JESD bank.
		White address 6-0F/H with 0 H for Channel A.	Main digital page (JESD bank)	This bit is a self-clearing bit.
		Write address 6-000h with 01h, then address 6-000h with 00h.	(* 2 2 2 7	Pulse the PULSE RESET register bit for both channels.
	3 Performance modes	Write address 0-011h with 80h.	_	Select the master page of the analog bank.
3		Write address 0-059h with 20h.	Master page (analog bank)	Set the ALWAYS WRITE 1 bit.
		The JESD mode (in the JESD digital page) and JESD PLL mode (in the device is in 20X serialization mode (4-lanes output).	ı the JESD analog բ	page) register bits control 20X or 40X serialization. By default after reset,
		Write address 4-003h with 00h and address 4-004h with 69h.	_	Select the JESD digital page.
		Write address 6-000h with 80h.	JESD	Set the CTRL K bit for both channels to program K for the SYSREF signal frequency in step 5.
		Write address 6-001h with 01h.	digital page (JESD bank)	Enable 20X serialization (4-lane output, default setting after reset).
		Write address 6-001h with 02h.	(OLOB Barnt)	Enable 40X serialization (2-lane output).
	Program registers for	Write address 4-003h with 00h and address 4-004h with 6Ah.	JESD	Select the JESD analog page.
4	20X or 40X serialization	Write address 6-016h with 00h	analog page	Enable 20X serialization (4-lane output, default setting after reset).
4	and program the HPF or LPF filter	Write address 6-016h with 02h	(JESD bank)	To enable 40X serialization (2-lane output).
	TINC	Write address 4-003h with 00h and address 4-004h with 68h.		Select the main digital page.
		Write address 6-052h with 80h and address 6-072h with 08h.		Set the ALWAYS WRITE 1 bit (enables correct order of the JESD output lanes).
		Write address 6-04Dh with 08h	Main digital page	Enable the decimation filter programming.
		Write address 6-041h with 12h	(JESD bank)	Enable the low-pass filter (default setting after reset).
		Write address 6-041h with 16h		Enable the high-pass filter.
		Write address 6-000h with 01h and address 6-000h with 00h.		Pulse the PULSE RESET register bit. All settings programmed in the main digital page take effect only after this bit is pulsed.



# Table 60. Initialization Sequence (continued)

STEP	SEQUENCE	DESCRIPTION	PAGE BEING PROGRAMMED	COMMENT
		Write address 4-003h with 00h and address 4-004h with 69h.	_	Select the JESD digital page.
5	Set the value of K and the SYSREF signal frequency accordingly	Write address 6-006h with XXh (choose the value of K).	JESD digital page (JESD bank)	Default value of K is 8 for 20X (4-lane) mode and 4 for 40X (2-lane) mode. However, K can be programmed for higher values than the default by using bits 4-0 of address 6-006 in the JESD digital page. For example, if K = 31 by writing address 6-006h with 1Fh in the JESD digital page, then the SYSREF signal frequency must be kept less than or equal to 250 MHz / 32 = 7.8125 MHz.
		Pull the SYNC pin (pin 63) low.		Transmit K28.5 characters.
6	JESD lane alignment	Pull the SYNC pin high.	_	After the receiver is synchronized, initiate an ILA phase and subsequent transmissions of ADC data.



#### 9.1.2 Hardware Reset

Figure 129 and Table 61 show the timing for a hardware reset.

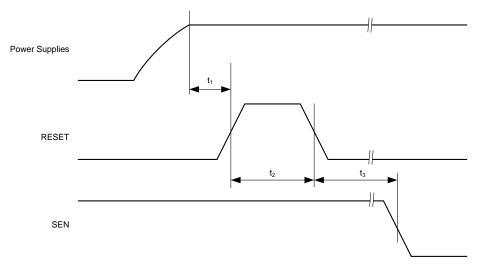


Figure 129. Hardware Reset Timing Diagram

Table 61. Timing Requirements for Figure 129

	MIN	TYP	MAX	UNIT
t <sub>1</sub> Power-on delay from power-up to active high RESET pulse	1			ms
t <sub>2</sub> Reset pulse duration: active high RESET pulse duration	10			ns
t <sub>3</sub> Register write delay: delay from RESET disable to SEN active	100			ns

#### 9.1.3 SNR and Clock Jitter

The signal-to-noise ratio (SNR) of the ADC is limited by three different factors: quantization noise, thermal noise, and jitter, as shown in Equation 4. The quantization noise is typically not noticeable in pipeline converters and is 98 dB for a 16-bit ADC. The thermal noise limits SNR at low input frequencies and the clock jitter sets SNR for higher input frequencies. The decimation-by-2 process gives approximately an additional 3-dB improvement in SNR.

$$SNR_{ADC}[dBc] = -3 - 20log \sqrt{\left(10^{-\frac{SNR_{Quantization Noise}}{20}}\right)^2 + \left(10^{-\frac{SNR_{Thermal Noise}}{20}}\right)^2 + \left(10^{-\frac{SNR_{Jitter}}{20}}\right)^2}$$
(4)

The SNR limitation resulting from the sample clock jitter can be calculated by Equation 5:

$$SNR_{Jitter}[dBc] = -20log(2\pi \times f_{in} \times T_{Jitter})$$
(5)

The total clock jitter  $(T_{Jitter})$  has two components: the internal aperture jitter (145  $f_S$ ) is set by the noise of the clock input buffer and the external clock jitter.  $T_{Jitter}$  can be calculated by Equation 6:

$$T_{Jitter} = \sqrt{\left(T_{Jitter, Ext\_Clock\_Input}\right)^2 + \left(T_{Aperture\_ADC}\right)^2}$$
(6)

External clock jitter can be minimized by using high-quality clock sources and jitter cleaners as well as band-pass filters at the clock input. A faster clock slew rate also improves the ADC aperture jitter.



The ADS54J69 has a thermal noise of approximately 71.1 dBFS and an internal aperture jitter of 120 f<sub>S</sub>. The SNR, depending on the amount of external jitter for different input frequencies, is shown in Figure 130.

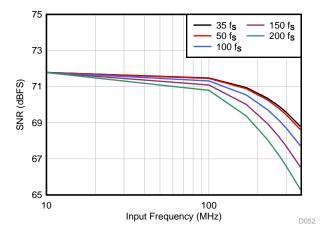


Figure 130. SNR versus Input Frequency and External Clock Jitter

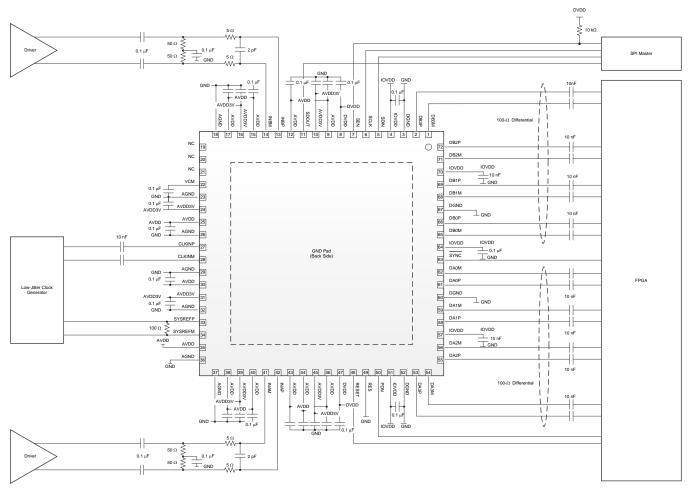
Half-band decimation filtering employed by the ADS54J69 reduces the affect of all contributors to SNR by 3 dB. Filtering makes the SNR curve in Figure 130 start at 74 dBFS despite a thermal noise of 71.1 dBFS.

Decimation filtering also improves the affect of jitter noise by 3 dB, and is equivalent to having 102  $f_S$  as the effective aperture jitter instead of 120  $f_S$ .



## 9.2 Typical Application

The ADS54J69 is designed for wideband receiver applications demanding excellent dynamic range over a large input frequency range. A typical schematic for an ac-coupled receiver is shown in Figure 131.



NOTE: GND = AGND and DGND connected in the PCB layout.

Figure 131. AC-Coupled Receiver

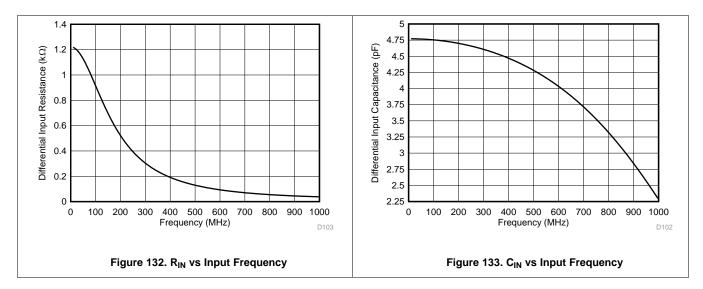


## **Typical Application (continued)**

#### 9.2.1 Design Requirements

#### 9.2.1.1 Transformer-Coupled Circuits

Typical applications involving transformer-coupled circuits are discussed in this section. Transformers (such as ADT1-1WT or WBC1-1) can be used up to 300 MHz to achieve good phase and amplitude balances at the ADC inputs. When designing dc driving circuits, the ADC input impedance must be considered. Figure 132 and Figure 133 show the impedance ( $Z_{IN} = R_{IN} \parallel C_{IN}$ ) across the ADC input pins.



By using the simple drive circuit of Figure 134, uniform performance can be obtained over a wide frequency range. The buffers present at the analog inputs of the device help isolate the external drive source from the switching currents of the sampling circuit.

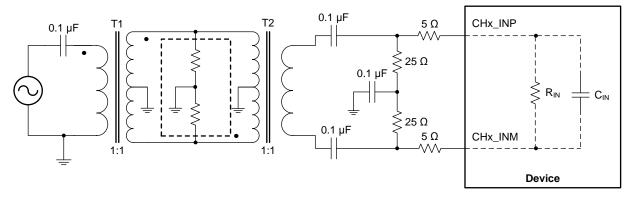


Figure 134. Input Drive Circuit

#### 9.2.2 Detailed Design Procedure

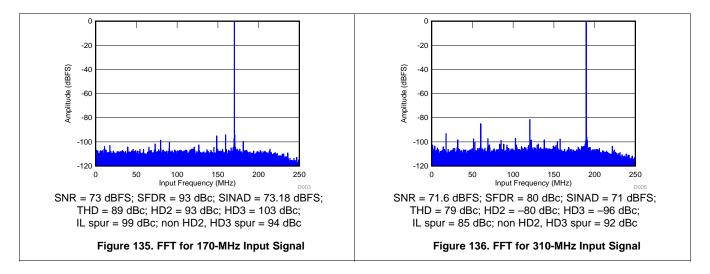
For optimum performance, the analog inputs must be driven differentially. This architecture improves common-mode noise immunity and even-order harmonic rejection. A small resistor (5  $\Omega$  to 10  $\Omega$ ) in series with each input pin is recommended to damp out ringing caused by package parasitics, as shown in Figure 134.



## **Typical Application (continued)**

### 9.2.3 Application Curves

Figure 135 and Figure 136 show the typical performance at 170 MHz and 230 MHz, respectively.



## 10 Power Supply Recommendations

The device requires a 1.15-V nominal supply for IOVDD, a 1.9-V nominal supply for DVDD, a 1.9-V nominal supply for AVDD, and a 3.0-V nominal supply for AVDD3V. For detailed information regarding the operating voltage minimum and maximum specifications of different supplies, see the *Recommended Operating Conditions* table.



### 10.1 Power Sequencing and Initialization

Figure 137 shows the suggested power-up sequencing for the device. Note that the 1.15-V IOVDD supply must rise before the 1.9-V DVDD supply. If the 1.9-V DVDD supply rises before the 1.15-V IOVDD supply, then the internal default register settings may not load properly. The other supplies (the 3-V AVDD3V and the 1.9-V AVDD), can come up in any order during the power sequence. The power supplies can ramp up at any rate and there is no hard requirement for the time delay between IOVDD ramp up to DVDD ramp-up (can be in orders of microseconds but is recommend to be a few milliseconds).

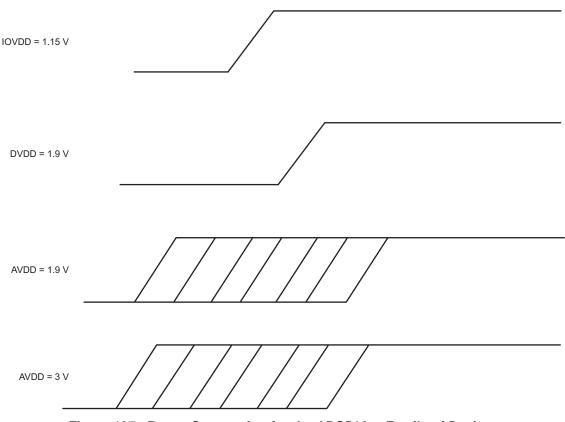


Figure 137. Power Sequencing for the ADS54Jxx Family of Devices



## 11 Layout

## 11.1 Layout Guidelines

The device evaluation module (EVM) layout can be used as a reference layout to obtain the best performance. A layout diagram of the EVM top layer is provided in Figure 138. A complete layout of the EVM is available from the ADS54J69EVM folder. Some important points to remember during board layout are:

- Analog inputs are located on opposite sides of the device pinout to ensure minimum crosstalk on the package level. To minimize crosstalk onboard, the analog inputs must exit the pinout in opposite directions, as illustrated in the reference layout of Figure 138 as much as possible.
- In the device pinout, the sampling clock is located on a side perpendicular to the analog inputs in order to minimize coupling between them. This configuration is also maintained on the reference layout of Figure 138 as much as possible.
- Keep digital outputs away from the analog inputs. When these digital outputs exit the pinout, the digital output
  traces must not be kept parallel to the analog input traces because this configuration can result in coupling
  from the digital outputs to the analog inputs and degrade performance. All digital output traces to the receiver
  [such as a field-programmable gate array (FPGA) or an application-specific integrated circuit (ASIC)] must be
  matched in length to avoid skew among outputs.
- At each power-supply pin (AVDD, DVDD, or AVDDD3V), keep a 0.1-μF decoupling capacitor close to the device. A separate decoupling capacitor group consisting of a parallel combination of 10-μF, 1-μF, and 0.1-μF capacitors can be kept close to the supply source.



# 11.2 Layout Example

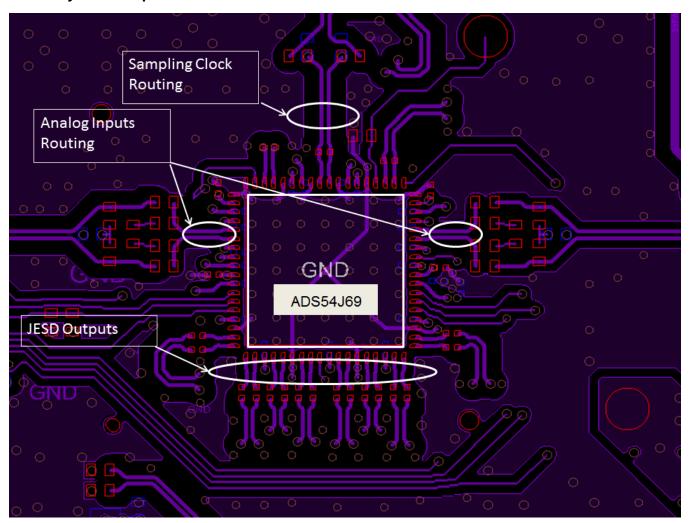


Figure 138. ADS54J69EVM layout



### 12 器件和文档支持

### 12.1 文档支持

#### 12.1.1 相关文档

相关文档如下:

- ADS54J20双通道 12 位 1.0GSPS 模数转换器
- ADS54J40 双通道 14 位 1.0GSPS 模数转换器
- ADS54J42 双通道、14 位、625MSPS 模数转换器
- ADS54J60 双通道 16 位 1.0GSPS 模数转换器
- ADS54J66 具有集成 DDC 的四通道、14 位、500MSPS ADC
- 《ADS54J69EVM 用户指南》

### 12.2 接收文档更新通知

如需接收文档更新通知,请访问 www.ti.com.cn 网站上的器件产品文件夹。点击右上角的提醒我 (Alert me) 注册后,即可每周定期收到已更改的产品信息。有关更改的详细信息,请查阅已修订文档中包含的修订历史记录。

#### 12.3 社区资源

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180

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ESD 的损坏小至导致微小的性能降级,大至整个器件故障。 精密的集成电路可能更容易受到损坏,这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

### 12.6 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

### 13 机械、封装和可订购信息

以下页中包括机械、封装和可订购信息。这些信息是针对指定器件可提供的最新数据。这些数据会在无通知且不对本文档进行修订的情况下发生改变。欲获得该数据表的浏览器版本,请查阅左侧的导航栏。



## PACKAGE OPTION ADDENDUM

10-Dec-2020

#### PACKAGING INFORMATION

www.ti.com

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
ADS54J69IRMP	ACTIVE	VQFN	RMP	72	168	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	AZ54J69	Samples
ADS54J69IRMPT	ACTIVE	VQFN	RMP	72	250	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	AZ54J69	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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10-Dec-2020



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## **TRAY**

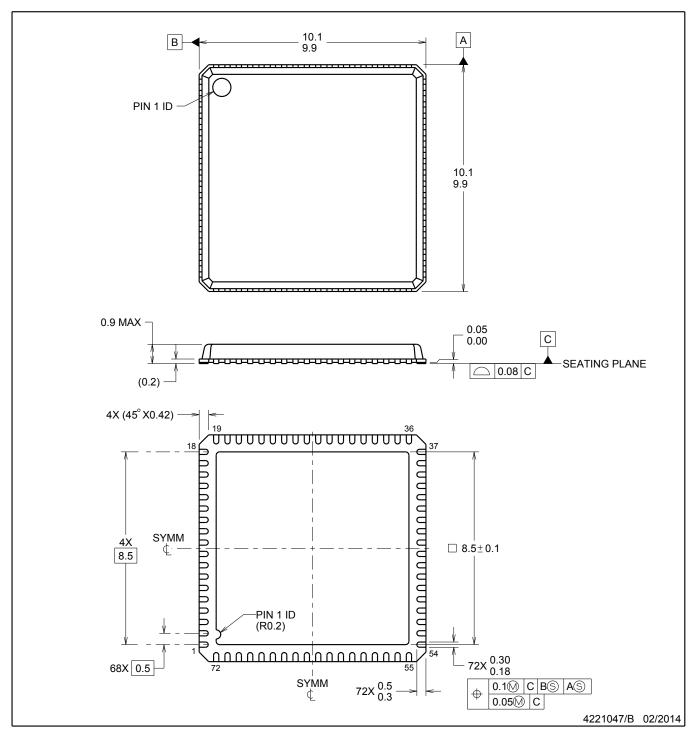


Chamfer on Tray corner indicates Pin 1 orientation of packed units.

\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)	W (mm)	Κ0 (μm)	P1 (mm)	CL (mm)	CW (mm)
ADS54J69IRMP	RMP	VQFNP	72	168	8 X 21	150	315	135.9	7620	14.65	11	11.95





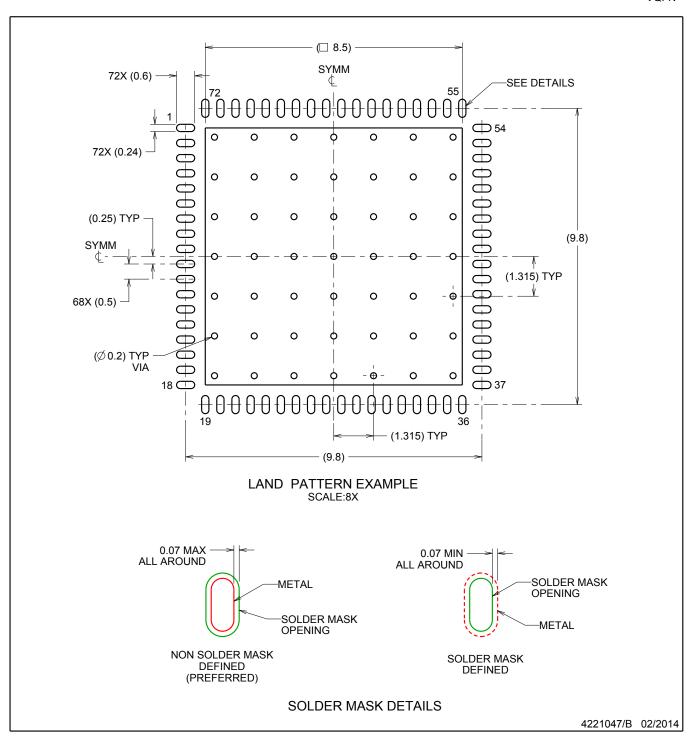
### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



**VQFN** 

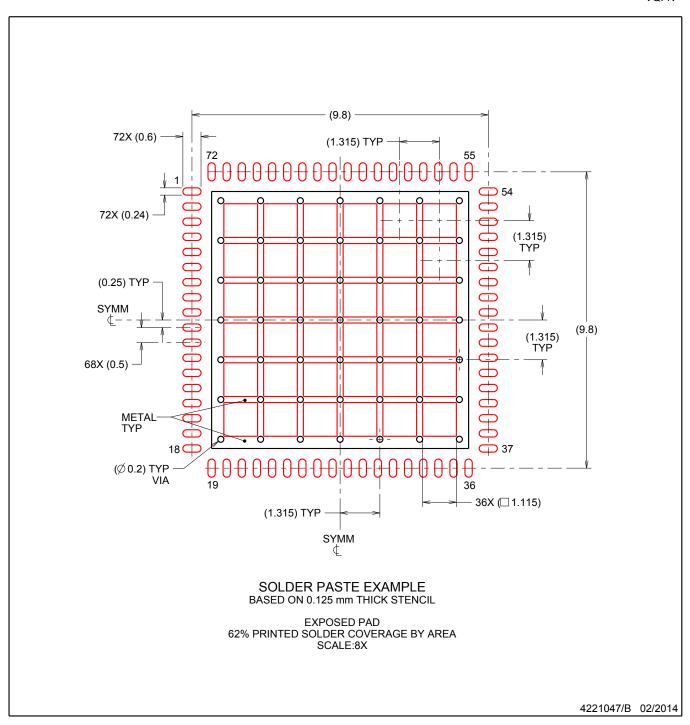


NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see QFN/SON PCB application report in literature No. SLUA271 (www.ti.com/lit/slua271).



VQFN



NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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